

Si5315

SYNCHRONOUS ETHERNET/TELECOM JITTER ATTENUATING CLOCK MULTIPLIER

Features

- Provides jitter attenuation and frequency translation between SONET/PDH and Ethernet
- Supports ITU-T G.8262 Synchronous Ethernet equipment slave clock (EEC option 1 and 2) requirements with optional Stratum 3 compliant timing card clock source
- Two clock inputs/two clock outputs
- Input frequency range: 8 kHz–644 MHz
- Output frequency range: 8 kHz–644 MHz■
- Ultra low jitter:
 0.23 ps RMS (1.875–20 MHz)
 0.47 ps RMS (12 kHz–20 MHz)
- Simple pin control interface

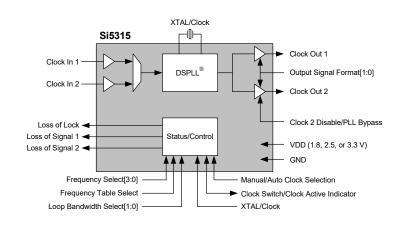
Applications

- Synchronous Ethernet line cards
- SONET OC-3/12/48 line cards
- PON OLT/ONU

Description

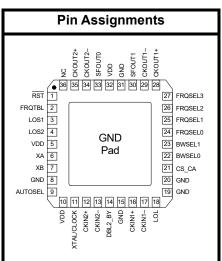
The Si5315 is a jitter-attenuating clock multiplier for Gb and 10G Synchronous Ethernet, SONET/SDH, and PDH (T1/E1) applications. The Si5315 supports SyncE EEC options 1 and 2 when paired with a timing card that implements the required wander filter. The Si5315 accepts dual clock inputs ranging from 8 kHz to 644.53 MHz and generates two equal frequency-multiplied clock outputs ranging from 8 kHz to 644.53 MHz. The input clock frequency and clock multiplication ratio are selectable from a table of popular SyncE and T1/E1 rates. The Si5315 is based on Skyworks Solutions' third-generation DSPLL[®] technology, which provides any-frequency synthesis and jitter attenuation in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The DSPLL loop bandwidth is user programmable, providing jitter performance optimization at the application level.

Functional Block Diagram



- Selectable loop bandwidth for jitter attenuation: 60 to 8.4 kHz
- Automatic/Manual hitless switching and holdover during loss of inputs clock
- Programmable output clock signal format: LVPECL, LVDS, CML or CMOS
- 40 MHz crystal or XO reference
 - Single supply: 1.8, 2.5, or 3.3 V On-chip voltage regulator with high PSRR
- Loss of lock and loss of signal alarms
- Small size: 6 x 6 mm, 36-QFN
- Wide temperature range: -40 to +85 °C
- Carrier Ethernet switches routers
- MSAN / DSLAM
- T1/E1/DS3/E3 line cards

Ordering Information: See page 48.



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TABLE OF CONTENTS

Section

Page

1. Electrical Specifications	1
1.1. Three-Level (3L) Input Pins (No External Resistors)	1
1.2. Three-Level (3L) Input Pins (With External Resistors)	2
2. Typical Application Circuit	
3. System Level Overview	5
4. Functional Description	3
4.1. Overview	3
4.2. PLL Performance	7
5. Frequency Plan Tables	
5.1. Frequency Multiplication Plan	9
5.2. PLL Self-Calibration	9
5.3. Input Clock Control)
5.4. Alarms	1
5.5. Holdover Mode	2
5.6. PLL Bypass Mode	2
6. High-Speed I/O	
6.1. Input Clock Buffers	
6.2. Output Clock Drivers	3
7. Crystal/Reference Clock Input	
7.1. Crystal/Reference Clock Selection	9
8. Power Supply Filtering41	
9. Typical Phase Noise Plots	
9.1. 10G LAN SyncE Example	2
10. Pin Descriptions: Si5315	3
11. Ordering Guide	
12. Package Outline: 36-Pin QFN)
13. PCB Land Pattern)
14. Top Marking	
14.1. Si5315 Top Marking (QFN)52	
14.2. Top Marking Explanation52	
Document Change List	
Contact Information	4

1. Electrical Specifications

Table 1. Recommended Operating Conditions

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, T_A = -40 \text{ to } 85 \text{ °C})$

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Temperature Range	T _A		-40	25	85	°C	
Supply Voltage	V _{DD}	3.3 V nominal	2.97	3.3	3.63	V	
		2.5 V nominal	2.25	2.5	2.75	V	
		1.8 V nominal	1.71	1.8	1.89	V	
Note: All minimum and maximum specifications are guaranteed and apply across the recommended operating conditions. Typical values apply at nominal supply voltages and an operating temperature of 25 °C unless otherwise noted.							

Table 2. DC Characteristics

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

Symbol	Test Condition	Min	Тур	Мах	Units
I _{DD}	LVPECL Format 644.53125 MHz Out All CKOUTs Enabled ¹		251	279	mA
	LVPECL Format 644.53125 MHz Out Only 1 CKOUT Enabled ¹	_	217	243	mA
	CMOS Format 25.00 MHz Out All CKOUTs Enabled ²	_	204	234	mA
	CMOS Format 25.00 MHz Out Only CKOUT1 Enabled ²	_	194	220	mA
			11		-1
V _{ICM}	1.8 V ± 5%	0.9		1.4	V
	2.5 V ± 10%	1.0	—	1.7	V
	3.3 V ± 10%	1.1	—	1.95	V
CKN _{RIN}	Single-ended	20	40	60	kΩ
CKN _{VIN}		0		V _{DD}	V
	I _{DD} V _{ICM}	$\begin{tabular}{ c c c c } \hline I_{DD} & LVPECL Format \\ 644.53125 MHz Out \\ All CKOUTs Enabled^1 \\ LVPECL Format \\ 644.53125 MHz Out \\ Only 1 CKOUT Enabled^1 \\ \hline CMOS Format \\ 25.00 MHz Out \\ All CKOUTs Enabled^2 \\ \hline CMOS Format \\ 25.00 MHz Out \\ Only CKOUT1 Enabled^2 \\ \hline V_{ICM} & 1.8 \ V \pm 5\% \\ \hline 2.5 \ V \pm 10\% \\ \hline 3.3 \ V \pm 10\% \\ \hline CKN_{RIN} & Single-ended \\ \hline \end{tabular}$	IDD LVPECL Format 644.53125 MHz Out All CKOUTs Enabled ¹ — LVPECL Format 644.53125 MHz Out Only 1 CKOUT Enabled ¹ — CMOS Format 25.00 MHz Out All CKOUTs Enabled ² — CMOS Format 25.00 MHz Out All CKOUTs Enabled ² — CMOS Format 25.00 MHz Out Only CKOUT1 Enabled ² — VICM 1.8 V ± 5% 0.9 2.5 V ± 10% 1.0 3.3 V ± 10% 1.1 CKN _{RIN} Single-ended 20 20	IDD LVPECL Format 644.53125 MHz Out All CKOUTs Enabled ¹ — 251 LVPECL Format 644.53125 MHz Out Only 1 CKOUT Enabled ¹ — 217 CMOS Format 25.00 MHz Out All CKOUTs Enabled ² — 204 CMOS Format 25.00 MHz Out All CKOUTs Enabled ² — 194 VICM 1.8 V ± 5% 0.9 — 2.5 V ± 10% 1.0 — 3.3 V ± 10% 1.1 — CKN _{RIN} Single-ended 20 40	IDD LVPECL Format 644.53125 MHz Out All CKOUTs Enabled ¹ 251 279 LVPECL Format 644.53125 MHz Out Only 1 CKOUT Enabled ¹ 217 243 CMOS Format 25.00 MHz Out All CKOUTs Enabled ² 204 234 CMOS Format 25.00 MHz Out All CKOUTs Enabled ² 194 220 CMOS Format 25.00 MHz Out Only CKOUT1 Enabled ² 1.4 VICM 1.8 V ± 5% 0.9 1.4 2.5 V ± 10% 1.0 1.7 3.3 V ± 10% 1.1 1.95 CKN _{RIN} Single-ended 20 40 60

1. Refers to Si5315A speed grade.

2. Refers to Si5315B speed grade.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 11.

Table 2. DC Characteristics (Continued)

(V_{DD} = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%, T_A = –40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Мах	Units
Single-ended Input Voltage Swing	V _{ISE}	f _{CKIN} ≤ 212.5 MHz See Figure 2.	0.2	—	_	V _{PP}
		f _{CKIN} > 212.5 MHz See Figure 2.	0.25	—	_	V _{PP}
Differential Input Voltage Swing	V _{ID}	f _{CKIN} ≤ 212.5 MHz See Figure 2.	0.2	—	_	V _{PP}
		f _{CKIN} > 212.5 MHz See Figure 2.	0.25	—		V _{PP}
CKOUTn Output Clocks		·				
Common Mode	V _{OCM}	LVPECL 100 Ω load line-to-line	V _{DD} – 1.42	—	V _{DD} – 1.25	V
Differential Output Swing	V _{OD}	LVPECL 100 Ω load line-to-line	1.1	—	1.9	V _{PP}
Single Ended Output Swing	V_{SE}	LVPECL 100 Ω load line-to-line	0.5	—	0.93	V _{PP}
Differential Output Voltage	CKO _{VD}	CML 100 Ω load line-to-line	350	425	500	mV _{PP}
Common Mode Output Voltage	CKO _{VCM}	CML 100 Ω load line-to-line	—	V _{DD} – 0.36	_	V
Differential Output Voltage	CKO _{VD}	LVDS 100 Ω load line-to-line	500	700	900	mV _{PP}
		Low swing LVDS 100 Ω load line-to-line	350	425	500	mV _{PP}
Common Mode Output Voltage	CKO _{VCM}	LVDS 100 Ω load line-to-line	1.125	1.2	1.275	V
Differential Output Resistance	CKO _{RD}	CML, LVPECL, LVDS, Disable	_	200		Ω
Output Voltage Low	CKO _{VOLLH}	CMOS		_	0.4	V
Output Voltage High	CKO _{VOHLH}	V _{DD} = 1.71 V CMOS	0.8 x V _{DD}	—	_	V

1. Refers to Si5315A speed grade.

Refers to Si5315B speed grade. 2.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 11.

5

Table 2. DC Characteristics (Continued)

(V_{DD} = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%, T_A = –40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Output Drive Current	СКО _{ІО}	CMOS Driving into CKO _{VOL} for out- put low or CKO _{VOH} for out- put high. CKOUT+ and CKOUT– shorted externally.				
		V _{DD} = 1.71 V	7.5	_	—	mA
		V _{DD} = 2.97 V	32	—	—	mA
2-Level LVCMOS Input Pins						
Input Voltage Low	V _{IL}	V _{DD} = 1.71 V	—	_	0.5	V
		V _{DD} = 2.25 V	—	_	0.7	V
		V _{DD} = 2.97 V	—	_	0.8	V
Input Voltage High	V _{IH}	V _{DD} = 1.89 V	1.4	_	—	V
		V _{DD} = 2.25 V	1.8	_	—	V
		V _{DD} = 3.63 V	2.5	_	—	V
Input Low Current	IIL		—	_	50	μA
Input High Current	IIH		—	_	50	μA
Weak Internal Input Pull-up Resistor	R _{PUP}		—	75	—	kΩ
Weak Internal Input Pull-down Resistor	R _{PDN}		—	75	—	kΩ
3-Level Input Pins			<u> </u>		- I	
Input Voltage Low	V _{ILL}		_	_	0.15 x V _{DD}	V
Input Voltage Mid	V _{IMM}		0.45 x V _{DD}	_	$0.55 ext{ x V}_{ ext{DD}}$	V
Input Voltage High	V _{IHH}		0.85 x V _{DD}	_	—	V
Input Low Current	I _{ILL}	See note 3.	-20	_		μA
Input Mid Current	I _{IMM}	See note 3.	-2		2	μA
Input High Current	IIHH	See note 3.			20	μA

2. Refers to Si5315B speed grade.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 11.

Table 2. DC Characteristics (Continued)

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

V _{OL}			I		
Vol					
	I _O = 2 mA V _{DD} = 1.62 V		—	0.4	V
	I _O = 2 mA V _{DD} = 2.97 V	—	—	0.4	V
V _{OH}	I _O = –2 mA V _{DD} = 1.62 V	V _{DD} – 0.4			V
	I _O = –2 mA V _{DD} = 2.97 V	V _{DD} – 0.4	—		V
I _{OZ}	RST = 0	-100	—	100	μA
k Input Pin XA ((XB with Cap to Gnd)				
XA _{RIN}	XTAL/CLOCK = M	—	12		kΩ
XA _{VIN}		0	—	1.2	V
XA _{VPP}		0.5	_	1.2	V _{PP}
nput Pins (XA/X	(В)		1		
XA/XB _{RIN}	XTAL/CLOCK = M	_	12		kΩ
XA/XB _{VIN}		0	—	1.2	V
XA _{VPP} /XB _{VPP}		0.5	_	2.4	V _{PP}
r	I _{OZ} k Input Pin XA XA _{RIN} XA _{VIN} XA _{VPP} nput Pins (XA/) XA/XB _{RIN} XA/XB _{VIN}	$V_{DD} = 2.97 V$ $V_{OH} = I_{O} = -2 mA$ $V_{DD} = 1.62 V$ $I_{O} = -2 mA$ $V_{DD} = 2.97 V$ $I_{OZ} = RST = 0$ k Input Pin XA (XB with Cap to Gnd) $XA_{RIN} = XTAL/CLOCK = M$ $XA_{VIN} = XA_{VPP}$ nput Pins (XA/XB) $XA/XB_{RIN} = XTAL/CLOCK = M$	$V_{DD} = 2.97 V$ $V_{OH} = 1.62 V$ $V_{DD} = 1.62 V$ $V_{DD} = 0.4$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 11.

Table 3. AC Characteristics

(V_{DD} = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%, T_A = –40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Мах	Units
Input Frequency	CKN _F		0.008		644.53	MHz
CKINn Input Pins	1					
Input Duty Cycle (Minimum		M/hishever is smalled	40		60	%
Pulse Width)	CKN _{DC}	Whichever is smaller ¹	2	_	_	ns
Input Capacitance	CKN _{CIN}		—		3	pF
Input Rise/Fall Time	CKN _{TRF}	20–80% See Figure 2	—	—	11	ns
CKOUTn Output Pins						
Output Frequency (Output not	CK.	Note 2	0.008		644.53	MHz
configured for CMOS or disable)	CK _{OF}	Note 3	0.008		125	MHz
Maximum Output Frequency in CMOS Format	CKO _{FMC}		—		161.13	MHz
Output Rise/Fall (20–80%) at 644.5313 MHz	CKO _{TRF}	Output not configured for CMOS or disabled, see Figure 2	—	230	350	ps
Single Ended Output Rise/Fall (20–80%)	CKO _{TRF}	CMOS Output V _{DD} = 1.62 Cload = 5 pF	—	_	8	ns
		CMOS Output V _{DD} = 2.97 Cload = 5 pF		_	2	ns
Output Duty Cycle Differential Uncertainty	СКО _{DC}	100 Ω Load Line to Line Measured at 50% Point (not for CMOS)	_	_	±40	ps
LVCMOS Pins	1					
Input Capacitance	C _{in}		_	_	3	pF
 Notes: 1. Assumes N3 does not equal 1 2. Refers to Si5315A speed grad 3. Refers to Si5315B speed grad 	le.	CKN _{DC} = 50 μs.				

Table 3. AC Characteristics (Continued) $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

Symbol	Test Condition	Min	Тур	Max	Units
•				L	
t _{RF}	CLOAD = 20 pf See Figure 2	—	25	_	ns
LOS _{TRIG}	From last CKINn ↑ to internal detection of LOSn		—	750	μs
t _{CLRLOL}	↓ LOS to ↓ LOL Assume Fold=Fnew, Stable XA-XB reference	_	10	_	ms
t _{SKEW}	↑ of CKOUTn to ↑ CKOUTn			100	ps
t _{TEMP}	Maximum phase change from –40 to +85 °C	—	300	500	ps
t _{LOCKHW}	↑ \overrightarrow{RST} with valid CKIN to ↓ LOL; BW = 100 Hz	—	1200	_	ms
J _{PK}			0.05	0.1	dB
J _{TOL}				ns pk- pk	
t _{RSTMIN}		1	_	_	μs
t _{P_STEP}	During clock switch CKIN <u>></u> 19.44 MHz	—	100	200	ps
t _{HISTAVG}		—	6.7	_	sec
t _{HISTDEL}		_	26.2	_	ms
SP _{SPUR}	Max spur @ n x f3 (n ≥ 1, n x f3 < 100 MHz)		-75		dBc
	t _{RF} LOS _{TRIG} t _{CLRLOL} t _{CLRLOL} t _{TEMP} t _{LOCKHW} J _{PK} J _{TOL} t _{RSTMIN} t _{P_STEP} t _{HISTAVG} t _{HISTDEL}	t_{RF} $CLOAD = 20 \text{ pf}$ See Figure 2 LOS_{TRIG} From last CKINn \uparrow to internal detection of LOSn t_{CLRLOL} \downarrow LOS to \downarrow LOL Assume Fold=Fnew, Stable XA-XB reference t_{SKEW} \uparrow of CKOUTn to \uparrow CKOUTn t_{TEMP} Maximum phase change from -40 to +85 °C t_{LOCKHW} \uparrow RST with valid CKIN to \downarrow LOL; BW = 100 Hz J_{PK} \downarrow J_{TOL} \downarrow t_{RSTMIN} \downarrow t_{P_STEP} During clock switch CKIN \geq 19.44 MHz $t_{HISTAVG}$ \downarrow $t_{HISTDEL}$ Max spur @ n x f3	t_{RF} CLOAD = 20 pf See Figure 2 LOS_{TRIG} From last CKINn \uparrow to internal detection of LOSn t_{CLRLOL} \downarrow LOS to \downarrow LOL Assume Fold=Fnew, Stable XA-XB reference t_{SKEW} \uparrow of CKOUTn to \uparrow CKOUTn t_{TEMP} Maximum phase change from -40 to +85 °C t_{LOCKHW} \uparrow RST with valid CKIN to \downarrow LOL; BW = 100 Hz J_{PK} J_{TOL} See 4 anc1 t_{RSTMIN} 11 t_{P_STEP} During clock switch CKIN \geq 19.44 MHz $t_{HISTDEL}$ Max spur @ n x f3	t_{RF} CLOAD = 20 pf See Figure 2—25 LOS_{TRIG} From last CKINn ↑ to internal detection of LOSn—— t_{CLRLOL} \downarrow LOS to \downarrow LOL Assume Fold=Fnew, Stable XA-XB reference—10 t_{SKEW} ↑ of CKOUTn to ↑ CKOUTn—— t_{TEMP} Maximum phase change from -40 to +85 °C—300 t_{LOCKHW} ↑ RST with valid CKIN to \downarrow LOL; BW = 100 Hz—1200 J_{PK} —0.05 J_{TOL} See 4.2.3. "Jitte ance" on pag t_{RSTMIN} 1— t_{P_STEP} During clock switch CKIN \geq 19.44— $t_{HISTAVG}$ —6.7 $t_{HISTDEL}$ Max spur @ n x f3—-75	tRFCLOAD = 20 pf See Figure 2-25-LOSTRIGFrom last CKINn ↑ to internal detection of LOSn750tCLRLOL \downarrow LOS to \downarrow LOL Assume Fold=Fnew, Stable XA-XB reference-10-tSKEW↑ of CKOUTn to ↑ CKOUTn100tTEMPMaximum phase change from -40 to +85 °C-300500tLOCKHW↑ RST with valid CKIN to \downarrow LOL; BW = 100 Hz-1200-JPK-0.050.1JPK-0.050.1JTOLSee 4.2.3. "Jitter Toler- ance" on page 18.1tRSTMIN1tP_STEPDuring clock switch CKIN ≥ 19.44 MHz-100200tHISTAVG-26.2SPacueMax spur @ n x f375-

Notes:

1. Assumes N3 does not equal 1. IF N3 = 1, CKN_{DC} = 50 μ s.

2. Refers to Si5315A speed grade.

3. Refers to Si5315B speed grade.

Table 4. Jitter Generation

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

Parameter	Symbol	Test Cond	lition ^{1,2,3,4}	Min	Тур	Тур	Тур	Max	GR-253 Spec	Unit
		Measuremen t Filter (MHz)	DSPLL BW ¹							
		0.02-80	167 Hz ⁵	_	0.483	0.628	N/A	ps _{rms}		
Jitter Gen OC-192	1	4–80	167 Hz ⁵	—	0.302	0.392	N/A	ps _{rms}		
	J _{GEN}	0.05–80	167 Hz ⁵		0.467	0.607	1.0 ps _{rms} (0.01 UI _{rms}	ps _{rms}		
Jitter Gen OC-48		0.012–20	167 Hz ⁵		0.470	0.611	4.02 ps _{rms} (0.01 UI _{rms})	ps _{rms}		
	J _{GEN}	0.012-20	111 Hz ⁶	_	0.565	0.734	4.02 ps _{rms} (0.01 UI _{rms})	ps _{rms}		
IEEE 802.3 GbE RMS Jitter	J _{GEN}	1.875–20	83 Hz ⁶	_	0.232	0.301		ps _{rms}		

Notes:

1. BWSEL [1:0] loop bandwidth settings provided in Table 9 on page 20.

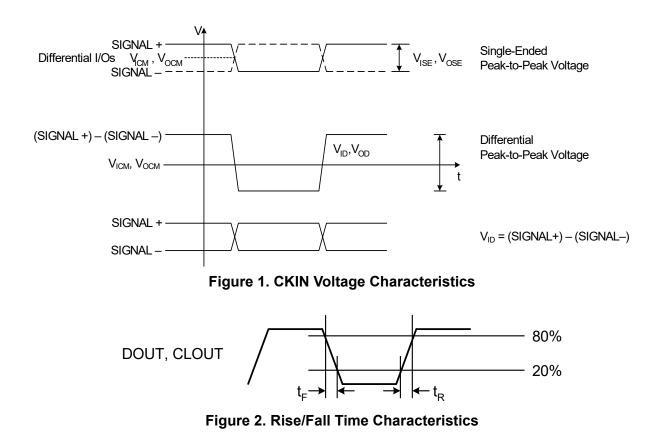
2. 40 MHz fundamental mode crystal used as XA/XB input.

3. V_{DD} = 2.5 V

4. $T_A = 85 °C$

 Si5315A test condition: f_{IN} = 19.44 MHz, f_{OUT} = 156.25 MHz, LVPECL clock input: 1.19 Vppd with 0.5 ns rise/fall time (20–80%), LVPECL clock output.

 Si5315B test condition: f_{IN} =19.44 MHz, f_{OUT} = 125 MHz, LVPECL clock input: 1.19 Vppd with 0.5 ns rise/fall time (20-80%), LVPECL clock output.



1.1. Three-Level (3L) Input Pins (No External Resistors)

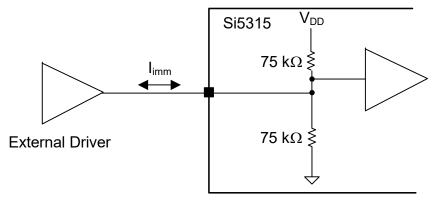
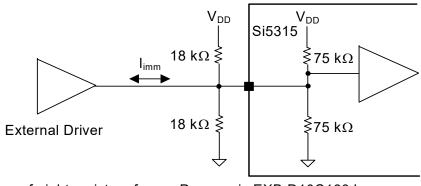


Figure 3. Three-Level Input Pins

Parameter	Symbol	Min	Мах				
Input Voltage Low	Vill	_	0.15 x V _{DD}				
Input Voltage Mid	Vimm	0.45 x V _{DD}	0.55 x V _{DD}				
Input Voltage High	Vihh	0.85 x V _{DD}	_				
Input Low Current	lill	-6 µA	—				
Input Mid Current	limm	-2 μA	2 μΑ				
Input High Current	lihh	_	6 µA				
Note: The above currents are the amount of leakage that the 3L inputs can tolerate from an external driver.							

1.2. Three-Level (3L) Input Pins (With External Resistors)



One of eight resistors from a Panasonic EXB-D10C183J (or similar) resistor pack

Figure 4. Three Level Input Pins

Table 6. Three-Level Input Pins (With External Resistors)

Parameter	Symbol	Min	Мах			
Input Low Current	lill	–30 μA				
Input Mid Current	limm	–11 μA	–11 μA			
Input High Current lihh — –30 µA						
Note: The above currents are the amount of leakage that the 3L inputs can tolerate from an external driver.						

- Any resistor pack may be used.
 - The Panasonic EXB-D10C183J is an example.
 - PCB layout is not critical.
- Resistor packs are only needed if the leakage current of the external driver exceeds the listed currents.
- If a pin is tied to ground or V_{DD}, no resistors are needed.
- If a pin is left open (no connect), no resistors are needed.

Table 7. Thermal Characteristics

(V _{DD} = 1.8 ±5%, 2	2.5 ±10%,	or 3.3 V ±1	0%, T _A = -	-40 to 85 °C)
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Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Thermal Resistance Junction to Ambient	θ_{JA}	Still Air	_	32		°C/W
Thermal Resistance Junction to Case	θ ^{JC}	Still Air		14		°C/W

Table 8. Absolute Maximum Limits

Parameter	Symbol	Value	Unit
DC Supply Voltage	V _{DD}	-0.5 to 3.8	V
LVCMOS Input Voltage	V _{DIG}	–0.3 to (V _{DD} + 0.3)	V
CKINn Voltage Level Limits	CKN _{VIN}	0 to V _{DD}	V
XA/XB Voltage Level Limits	XA _{VIN}	0 to 1.2	V
Operating Junction Temperature	T _{JCT}	–55 to 150	С
Storage Temperature Range	T _{STG}	–55 to 150	С
ESD HBM Tolerance (100 pF, 1.5 kΩ); All pins except CKIN+/CKIN–		2	kV
ESD MM Tolerance; All pins except CKIN+/CKIN–		150	V
ESD HBM Tolerance (100 pF, 1.5 kΩ); CKIN+/CKIN–		750	V
ESD MM Tolerance; CKIN+/CKIN–		100	V
Latch-Up Tolerance		JESD78 Compli	ant
Note: Permanent device damage may occur if the Absolute Maximur restricted to the conditions as specified in the operation section rating conditions for extended periods of time may affect device	ns of this data s	-	

2. Typical Application Circuit

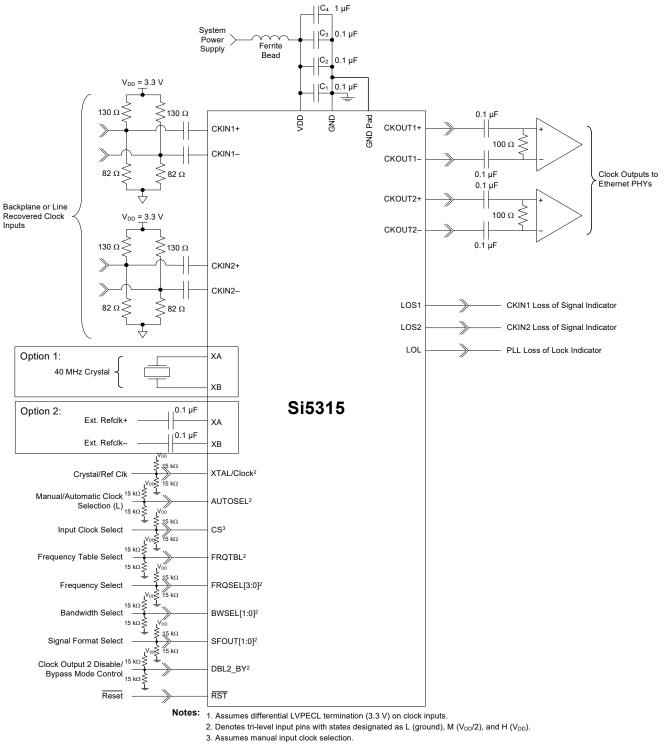


Figure 5. Si5315 Typical Application Circuit

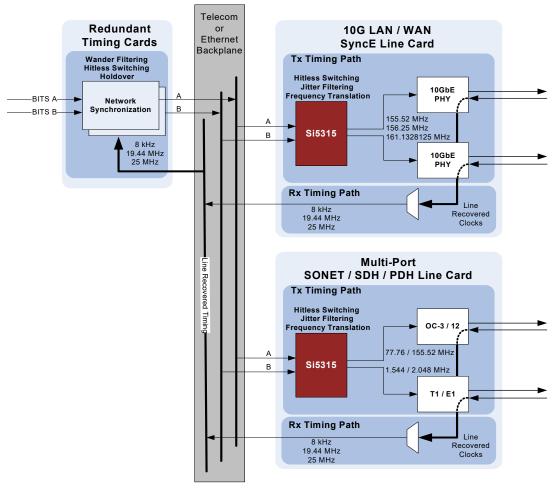
3. System Level Overview

The Si5315 provides clock translation, jitter attenuation, and clock distribution for high-performance Synchronous Ethernet* line card timing applications.

*Note: The Si5315 supports SyncE EEC options 1 and 2 when paired with a timing card that implements the required wander filtering and Stratum 3 compliant reference clock. For detailed information, refer to "AN420: SyncE and IEEE 1588: Sync Distribution for a Unified Network".

The Si5315 provides clock translation, jitter attenuation, and clock distribution for high-performance Synchronous Ethernet line card timing applications. The device accepts two clock inputs ranging from 8 kHz to 644.53 MHz and generates two equal frequency, low jitter clock outputs ranging from 8 kHz to 644.53 MHz. For ease of use, the Si5315 is pin controlled to enable simple device configuration of frequency plans, PLL loop bandwidth, and input clock selection. The DSPLL locks to one of two input reference clocks and provides over 200 frequency translations to synchronize output clocks for Ethernet, SONET/SDH, and PDH line cards. The Si5315 implements internal state machines to control hitless switching between input clocks and holdover. Status alarms, loss of signal (LOS) and loss of lock (LOL) are provided on output pins to indicate a change in device status.

This device is designed for systems with line cards that are synchronized to a redundant, centralized telecom or Ethernet backplane. The Si5315 synchronizes to backplane clocks and generates a multiplied, jitter attenuated Ethernet/SONET/SDH clock or PDH clock. A typical system application is shown in Figure 6. The Si5315 translates a 19.44 MHz clock from the telecom backplane to an Ethernet or SONET/SDH clock frequency to the PHY and filters the jitter to ensure compliance with related ITU-T and Telcordia standards.





4. Functional Description

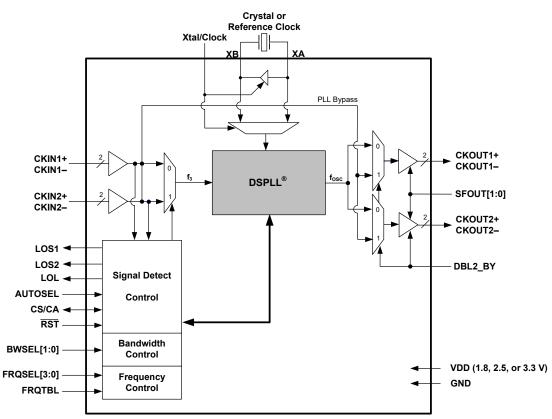


Figure 7. Detailed Block Diagram

4.1. Overview

The Si5315 is a jitter-attenuating precision clock multiplier for Synchronous Ethernet, SONET/SDH, and PDH (T1/E1) applications. The Si5315 accepts dual clock inputs ranging from 8 kHz to 644.53 MHz and generates two frequency-multiplied clock outputs ranging from 8 kHz to 644.53 MHz. The two input clocks are at the same frequency and the two output clocks are at the same frequency. The input clock frequency and clock multiplication ratio are selectable from a look up table of popular SyncE and T1/E1 rates.

The Si5315 is based on Skyworks Solutions' 3rd-generation DSPLL[®] technology, which provides any-frequency synthesis and jitter attenuation in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The Si5315 PLL loop bandwidth is selectable via the BWSEL[1:0] pins and supports a range from 60 to 8.4 kHz.

The Si5315 supports hitless switching between the two input clocks in compliance with ITU-T G.8262 and Telcordia GR-253-CORE and GR-1244-CORE. This feature greatly minimizes the propagation of phase transients to the clock outputs during an input clock transition (<200 ps typ). Manual and automatic revertive and non-revertive input clock switching options are available via the AUTOSEL input pin. The Si5315 monitors both input clocks for loss-of-signal and provides a LOS alarm when it detects missing pulses on either input clock. The device monitors the lock status of the PLL. The lock detect algorithm works by continuously monitoring the phase of the input clock in relation to the phase of the feedback clock. The Si5315 provides a holdover capability that allows the device to continue generation of a stable output clock when the selected input reference is lost.

The Si5315 has two differential clock outputs. The signal format of the clock outputs is programmable to support LVPECL, LVDS, CML, or CMOS loads. The second clock output can be powered down to minimize power consumption. For system-level debugging, a bypass mode is available which drives the output clock directly from the input clock, bypassing the internal DSPLL. The device operates from a single 1.8, 2.5, or 3.3 V supply.

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4.2. PLL Performance

The Si5315 provides extremely low jitter generation, a well-controlled jitter transfer function, and high jitter tolerance due to the high level of integration.

4.2.1. Jitter Generation

Jitter generation is defined as the amount of jitter produced at the output of the device with a jitter free input clock. Generated jitter arises from sources within the VCO and other PLL components. Jitter generation is a function of the PLL bandwidth setting. Higher loop bandwidth settings may result in lower jitter generation, but may result in less attenuation of jitter that might be present on the input clock signal.

4.2.2. Jitter Transfer

Jitter transfer is defined as the ratio of output signal jitter to input signal jitter for a specified jitter frequency. The jitter transfer characteristic determines the amount of input clock jitter that passes to the outputs. The DSPLL technology used in the Si5315 provides tightly controlled jitter transfer curves because the PLL gain parameters are determined largely by digital circuits which do not vary over supply voltage, process, and temperature. In a system application, a well-controlled transfer curve minimizes the output clock jitter variation from board to board and provides more consistent system level jitter performance.

The jitter transfer characteristic is a function of the loop bandwidth setting. Lower bandwidth settings result in more jitter attenuation of the incoming clock, but may result in higher jitter generation. Figure 8 shows the jitter transfer curve mask.

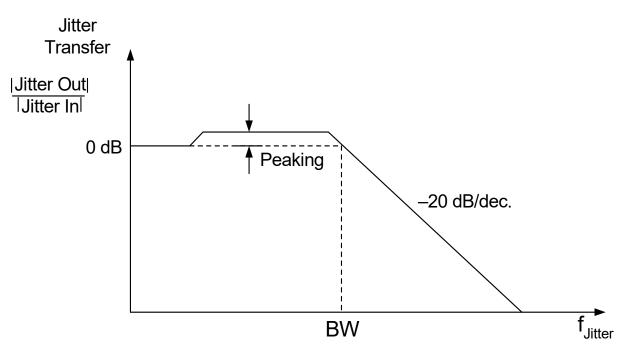


Figure 8. PLL Jitter Transfer Mask/Template

4.2.3. Jitter Tolerance

Jitter tolerance is defined as the maximum peak-to-peak sinusoidal jitter that can be present on the incoming clock before the DSPLL loses lock. The tolerance is a function of the jitter frequency, because tolerance improves for lower input jitter frequency.

The jitter tolerance of the DSPLL is a function of the loop bandwidth setting. Figure 9 shows the general shape of the jitter tolerance curve versus input jitter frequency. For jitter frequencies above the loop bandwidth, the tolerance is a constant value A_{j0} . Beginning at the PLL bandwidth, the tolerance increases at a rate of 20 dB/decade for lower input jitter frequencies.

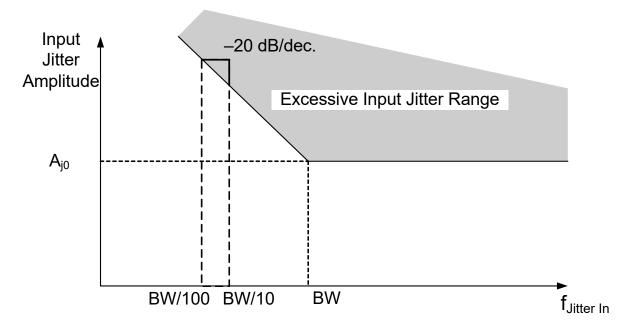


Figure 9. Jitter Tolerance Mask/Template

The equation for the high frequency jitter tolerance can be expressed as a function of the PLL loop bandwidth (i.e., BW):

$$A_{j0} = \frac{5000}{BW}$$
 ns pk-pk

For example, the jitter tolerance when f_{in} = 19.44 MHz, f_{out} = 161.13 MHz and the loop bandwidth (BW) is 113 Hz:

$$A_{j0} = \frac{5000}{113} = 44.24 \text{ ns pk-pk}$$

4.2.4. Jitter Attenuation Performance

The Internal VCO uses the reference clock on the XA/XB pins as its reference for jitter attenuation. The XA/XB pins support either a crystal input or an input buffer single-ended or differential clock input, such that an external oscillator can become the reference source. In either case, the device accepts a wide margin in absolute frequency of the reference input. (See 5.5. "Holdover Mode" on page 32.) In holdover, the Si5315's output clock stability matches the reference supplied on the XA/XB pins. The external crystal or reference clock must be selected based on the stability requirements of the application if holdover is a key requirement.

However, care must be exercised in certain areas for optimum performance. For examples of connections to the XA/XB pins, refer to 7. "Crystal/Reference Clock Input" on page 38.

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5. Frequency Plan Tables

For ease of use, the Si5315 is pin controlled to enable simple device configuration of the frequency plan and PLL loop bandwidth via a predefined look up table. The DSPLL has been optimized for each frequency multiplication and PLL loop bandwidth provided in Table 9 on page 20.

Many of the control inputs are three levels: High, Low, and Medium. High and Low are standard voltage levels determined by the supply voltage: V_{DD} and Ground. If the input pin is left floating, it is driven to nominally half of V_{DD} . Effectively, this creates three logic levels for these controls. See 1.2. "Three-Level (3L) Input Pins (With External Resistors)" on page 12 and 8. "Power Supply Filtering" on page 41 for additional information.

5.1. Frequency Multiplication Plan

The input to output clock multiplication is set by the 3-level FRQSEL[3:0] pins. The device provides a wide range of commonly used SyncE, SONET/SDH, and PDH frequency translations. The CKIN1 and CKIN2 inputs must be the same frequency as specified in Table 9. Both CKOUT1 and CKOUT2 outputs are at the same frequency.

5.1.1. PLL Loop Bandwidth Plan

The Si5315's loop bandwidth ranges from 60 Hz to 8.4 kHz. For each frequency multiplication, its corresponding loop bandwidth is provided in a simple look up table. (See Table 9 on page 20.) The loop bandwidth (BW) is digitally programmable using the 3-level BWSEL [1:0] and FRQTBL input pins.

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9. Look Up T
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	Plan #	fin	four	FRQTBL	FRQSEL		Loop	Bandwidth	Loop Bandwidth Selection (Hz), BWSEL[1:0]	(Hz), BWSE	:L[1:0]	
0008 0.008 L LLLL 257 60 <th></th> <th>(MHz)</th> <th>(MHz)</th> <th></th> <th>[3:0]</th> <th>L</th> <th>Ч</th> <th>ML</th> <th>MM</th> <th>ΗW</th> <th>Ч</th> <th>Ŧ</th>		(MHz)	(MHz)		[3:0]	L	Ч	ML	MM	ΗW	Ч	Ŧ
0 0008 1:544 L LLLM 257 60 <	-	0.008	0.008		LLLL	257	60				I	
0.008 2.048 L LLLLH 0.008 8.192 L LLMM 0.008 19.44 L LLMM 0.008 19.44 L LLMM 0.008 19.44 L LLMM 0.008 32.768 L LLMH 0.008 34.368 M LLLH 0.008 34.368 M LLHH 0.008 34.368 M LLHH 257 60 0.008 34.368 M LLHH 257 60 0.008 44.736 M LLM 0.008 155.52 H LLM 0.008	2	0.008	1.544		LLLM	257	60		1		I	
0.008 8.192 L LLML 257 60 </td <td>3</td> <td>0.008</td> <td>2.048</td> <td></td> <td>ГГГН</td> <td>257</td> <td>60</td> <td>1</td> <td></td> <td> </td> <td>I</td> <td> </td>	3	0.008	2.048		ГГГН	257	60	1			I	
0.008 19.44 L LLIM 257 60 </td <td>4</td> <td>0.008</td> <td>8.192</td> <td></td> <td>LLML</td> <td>257</td> <td>60</td> <td> </td> <td> </td> <td> </td> <td>I</td> <td> </td>	4	0.008	8.192		LLML	257	60				I	
	5	0.008	19.44		LLMM	257	60	1			I	
0.008 32.768 L LLLL 257 60 0.008 34.368 M LLLL 257 60 0.008 38.88 M LLLH 257 60 0.008 51.84 M LLHL 257 60	9	0.008	25		LLMH	257	60				I	
	7	0.008	32.768		LLHL	257	60				I	
	8	0.008	34.368	Σ	LLLL	257	60				I	
	o	0.008	38.88	Z	LLLM	257	60				I	
	10	0.008	44.736	Σ	LLLH	257	60			Ι	Ι	Ι
	11	0.008	51.84	Σ	LLML	257	60				I	
	12	0.008	65.536	Σ	LLMM	257					I	
	13	0.008	77.76	Z	LLMH	257	60				I	
	14	0.008	125	Σ	LLHL	257	60				I	
	15	0.008	155.52	н	LLLL	257	60				I	
	16	0.008	156.25	т	LLLM	257	60				I	
	17	0.008	311.04	т	ГГГН	257	60				I	
	18	0.008	312.5	т	LLML	257	60				I	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	19	0.008	622.08	т	LLMM	257	60				I	
1.544 1.544 L LHH 6047 1451 359 179 1.544 2.048 L LMLL 257 60 1.544 2.048 L LMLL 257 60 1.544 8.192 L LMLM 257 60 1.544 19.44 L LMLH 257 60	20	1.544	0.008		LLHM	257	60	1			I	
1.544 2.048 L LMLL 257 60 1.544 8.192 L LMLM 257 60 1.544 19.44 L LMLH 257 60	21	1.544	1.544		LLHH			6047	1451	359	179	89
1.544 8.192 L LMLM 257 60	22	1.544	2.048		LMLL	257	60				I	
1.544 19.44 L LMLH 257 60 — — — — — — —	23	1.544	8.192		LMLM	257	60				I	
	24	1.544	19.44		LMLH	257	60				I	

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Plan #	fın	four	FRQTBL	FRQSEL		Loop	Bandwidth	Selection (Loop Bandwidth Selection (Hz), BWSEL[1:0]	L[1:0]	
	(MHz)	(MHz)		[3:0]	LM	LH	ML	MM	ΗW	Ŧ	표
25	1.544	25	_	LMML	257	60					
26	1.544	32.768		LMMM	257	60				1	
27	1.544	34.368	Σ	LLHM	257	60					1
28	1.544	38.88	Σ	ГСНН	257	60	1				1
29	1.544	44.736	Σ	LMLL	257	60				1	1
30	1.544	51.84	Σ	LMLM	257	60	1				1
31	1.544	65.536	Σ	LMLH	257						
32	1.544	77.76	Σ	LMML	257	60					
33	1.544	125	Σ	LMMM	257	60	1				1
34	1.544	155.52	т	LLMH	257	60				1	1
35	1.544	156.25	т	LLHL	257	60	I			I	
36	1.544	311.04	т	LLHM	257	60				1	
37	1.544	312.5	т	ГСНН	257	60				Ι	
38	1.544	622.08	т	LMLL	257	60					1
39	2.048	0.008		LMMH	2089	485	240	59			1
40	2.048	1.544		LMHL	1037	242	119				I
41	2.048	2.048		LMHM	I		3949	959	238	118	59
42	2.048	8.192	_	LMHH			3949	959	238	118	59
43	2.048	19.44		LHLL			3946	958	238	118	59
44	2.048	25		LHLM	2087	485	240			1	1
45	2.048	32.768	_	ГНГН			3947	959	238	118	59
46	2.048	34.368	Σ	LMMH		8163	3935	958	238	118	1
47	2.048	38.88	Σ	LMHL			3946	958	238	118	59
48	2.048	44.736	Σ	LMHM		3983	1944	477	118	59	1
49	2.048	51.84	Σ	LMHH			3946	958	238	118	59
Notes: 1. F _{IN} 2. Si5 3. Si5	l and F _{OUT} fr 3315A suppor 3315B suppor	F _{IN} and F _{OUT} frequency values may be Si5315A supports all frequency plans. Si5315B supports output frequency pla	es may be rot cy plans. tuency plans t	F _{IN} and F _{OUT} frequency values may be rounded off. For exact multiplication ratios, please contact Skyworks Solutions. Si5315A supports all frequency plans. Si5315B supports output frequency plans up to 125 MHz.	act multiplica	tion ratios, pl	lease contac	t Skyworks S	olutions.		

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	(MHz)	(MHz)		[3:0]	LM	ГН	ML	MM	HW	Ŧ	王
50	2.048	65.536	Þ	LHLL		8185	3940	958	238	118	I
51	2.048	77.76	Σ	LHLM			3946	958	238	118	59
52	2.048	125	Þ	LHLH	1037	242	119			1	1
53	2.048	155.52	т	LMLM			3946	958	238	118	59
54	2.048	156.25	т	LMLH	1037	242	119		I	1	1
55	2.048	311.04	т	LMML			3946	958	238	118	59
56	2.048	312.5	т	LMMM	1037	242	119			1	
57	2.048	622.08	т	LMMH			3946	958	238	118	59
58	8.192	0.008		LHML	2089	485	240	59		1	1
59	8.192	1.544		LHMM	1037	242	119		I	I	I
60	8.192	2.048	_	ГНМН	Ι		6434	1541	381	190	95
61	8.192	8.192	_	LHHL			6434	1541	381	190	95
62	8.192	19.44	_	СННМ			3946	958	238	118	59
63	8.192	25		LHHH	2087	485	240		I	I	1
64	8.192	32.768		MLLL			6431	1541	381	190	95
65	8.192	34.368	Σ	LHML		8163	3935	958	238	118	
66	8.192	38.88	Σ	LHMM			3946	958	238	118	59
67	8.192	44.736	Σ	LHMH		3983	1944	477	118	59	
68	8.192	51.84	Σ	LHHL			3946	958	238	118	59
69	8.192	65.536	Σ	LHHM			6411	1539	381	190	95
20	8.192	77.76	Þ	СННН			3946	958	238	118	59
71	8.192	125	Σ	MLLL	1037	242	119			I	
72	19.44	0.008		MLLM	1759	409	202		I	1	1
73	19.44	1.544	_	MLLH		2779	1362	335	83	1	
74	19.44	2.048		MLML		3348	1638	402	100	I	I
Notes: 1. F _{IN} 2. Si5 3. Si5	and F _{OUT} fre 315A suppor 315B suppor	equency valu ts all frequen ts output frec	es may be rou cy plans. tuency plans u	F _{IN} and F _{OUT} frequency values may be rounded off. For exact multiplication ratios, please contact Skyworks Solutions. Si5315A supports all frequency plans. Si5315B supports output frequency plans up to 125 MHz.	sxact multiplica	tion ratios, pl	lease contac	t Skyworks S	olutions.		

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Plan #	fin	four	FRQTBL	FRQSEL		Loop	Bandwidth		Selection (Hz), BWSEL[1:0]	: L[1:0]	
	(MHz)	(ZHM)		[3:0]	ΓW	ГН	ML	MM	ΗW	нГ	포
75	19.44	8.192		MLMM		3348	1638	402	100		I
76	19.44	19.44		MLMH			7706	1832	452	225	112
77	19.44	25	_	MLHL		2778	1362	335	83		I
78	19.44	32.768		MLHM			5022	1215	301	150	75
79	19.44	34.368	Σ	MLLM		5662	2749	672	167	83	
80	19.44	38.88	Σ	MLLH			7703	1832	452	225	112
81	19.44	44.736	Σ	MLML		5653	2747	672	167	83	I
82	19.44	51.84	Σ	MLMM			7696	1832	452	225	112
83	19.44	65.536	Σ	MLMH	2618	607	300	74			
84	19.44	77.76	Μ	MLHL			7696	1832	452	225	112
85	19.44	125	Σ	MLHM	3960	913	450	111			Ι
86	19.44	155.52	н	LMHL			7696	1832	452	225	112
87	19.44	156.25	т	LMHM	6003	1373	677	167			I
88	19.44	161.1328	т	LMHH	484	113					
89	19.44	311.04	т	LHLL			7696	1832	452	225	112
06	19.44	312.5	т	LHLM	6003	1373	677	167			I
91	19.44	622.08	т	ГНГН			7696	1832	452	225	112
92	19.44	644.5313	т	LHML	103						
93	25	0.008		MLHH			7045	1681	415	207	103
94	25	1.544		MMLL	6741	1529	753	186			
95	25	2.048		MMLM	1299	303	150				
96	25	8.192		MMLH	6737	1529	753	186			
67	25	19.44		MMML			6551	1568	387	193	96
98	25	25	_	MMMM			7615	1812	447	223	111
66	25	32.768	_	MMMH	6737	1529	753	186			I
Notes: 1. F _{IN} 2. Si5 3. Si5	and F _{OUT} fr 315A suppol 315B suppol	equency value rts all frequene rts output freq	es may be ro cy plans. uency plans i	F _{IN} and F _{OUT} frequency values may be rounded off. For exact multiplication ratios, please contact Skyworks Solutions. Si5315A supports all frequency plans. Si5315B supports output frequency plans up to 125 MHz.	exact multiplica	ation ratios, p	lease contac	t Skyworks S	olutions.		

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Plan #	J	four	FRQTBL	FRQSEL	Plan # f _{IN} f _{OLIT} FRQTBL FRQSEL Loop Bandwidth Selection (Loop	Bandwidth	Selection (Loop Bandwidth Selection (Hz), BWSEL[1:0]	L[1:0]	
	(MHz)	(MHz)		[3:0]	LM	Н	ML	MM	ΗW	F	Ħ
100	25	34.368	Σ	MLHH	6722	1528	753	186		1	I
101	25	38.88	Σ	MMLL	6729	1529	753	186			
102	25	44.736	Σ	MMLM	1298	303	150	1			
103	25	50	т	НМЦН	I		7880	1880	470	230	120
104	25	51.84	Σ	MMLH		7988	3846	936	232	116	
105	25	65.536	Σ	MMML	1298	303	150				
106	25	77.76	Σ	MMMM	6706	1528	753	186	I		
107	25	125	Σ	MMMH	1		7606	1811	447	223	111
108	25	155.52	т	LHMM	1298	303	150				
109	25	156.25	т	LHMH			7606	1811	447	223	111
110	25	161.1328	т	LHHL			6106	1468	363	181	06
111	25	311.04	т	LHHM	1298	303	150	1			
112	25	312.5	т	СННН			7606	1811	447	223	111
113	25	622.08	т	MLLL	1298	303	150	1			
114	25	644.5313	т	MLLM	1		6106	1468	363	181	06
115	32.768	0.008		MMHL	2089	485	240	59			
116	32.768	1.544		MMHM	1037	242	119	1			
117	32.768	2.048		HHMM			7187	1714	423	211	105
118	32.768	8.192	_	MHLL	1		7632	1816	448	223	111
119	32.768	19.44		MHLM			3946	958	238	118	59
120	32.768	25	_	MHLH	2087	485	240				
121	32.768	32.768	_	MHML	I		7632	1816	448	223	111
122	32.768	34.368	Σ	MMHL	1	8163	3935	958	238	118	
123	32.768	38.88	Σ	MMMM				958	238	118	59
124	32.768	44.736	Σ	HHMM	1	3983	1944	477	118	59	
Notes: 1. F _{IN} 2. Si5	and F _{OUT} free	F _{IN} and F _{OUT} frequency values may b Si5315A supports all frequency plans.	es may be rou by plans.	e rounded off. For e	F _{IN} and F _{OUT} frequency values may be rounded off. For exact multiplication ratios, please contact Skyworks Solutions. Si5315A supports all frequency plans.	ttion ratios, pl	lease contact	. Skyworks S	olutions.		
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32.768 51.34 M MHLL 3946 958 238 118 32.768 77.76 M MHLH 7604 1815 448 223 32.768 77.76 M MHLH 7004 1860 476 230 50 50 M MHLH 770 1860 466 230 77.76 50 50 M MHLH 770 1860 466 230 77.76 1.544 L MHLH 7770 1860 466 230 77.76 1.544 L MHH 7770 1860 466 230 77.76 1.544 L MHH 7770 1879 464 231 77.76 19.44 L MHH 7705 1879 462 230 77.76 19.44 M MHH		(MHz)	(MHz)		[3:0]	LM	Н	МΓ	MM	ΗW	Ŧ	H
32.768 65.536 M MHLM 7604 1815 448 223 32.768 77.76 M MHLH 3946 958 238 118 32.768 77.76 M MHLH 3946 958 233 118 50 25 L HHHH 7800 1880 470 230 77.76 0.008 L MHHH 7770 1850 466 230 77.76 0.1544 L MHH 7770 1850 485 230 230 77.76 1944 L MHH 770 1850 486 231 77.76 34.368 M MHH 7705 1879 464 231 77.76 38.88 M MHH 7905 1879 464 231 77.76 51.84 M MHH	125	32.768	51.84	Σ	MHLL	l		3946	958	238	118	59
32.768 77.76 M MHLH $$ $$ 32.768 17.76 M MHLH 32.768 125 M MHML $$	126	32.768	65.536	Σ	MHLM			7604	1815	448	223	111
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	127	32.768	77.76	Σ	MHLH			3946	958	238	118	59
50 25 L HHHH 7770 7880 470 230 77.76 50 M HMLH 7770 1850 466 230 77.76 1.544 L MHM 2779 1362 35 83 77.76 1.544 L MHH 7905 1362 363 83 77.76 1.944 L MHH 7905 1369 464 231 77.76 38.88 M MHH 7905 1369 464 231 77.76 38.88 M MHH 7905 1879 464 231 77.76 38.88 M MHH 7905 1879 464 231 77.76 38.88 M MHH 7905 1879 464 231 77.76 51.84 MHH	128	32.768	125	Σ	MHML	1037	242	119				
50 50 M HMLH 7770 1850 466 230 77.76 1.544 L MHMH -008 L MHMH 2779 59 - 77.76 1.544 L MHH 2779 1362 335 83 77.76 19.44 L MHH 7905 1879 464 231 77.76 24.358 M MHH 7905 1879 464 231 77.76 38.88 M MHH 7905 1879 464 231 77.76 38.88 M MHH 7905 1879 464 231 77.76 51.84 M MHH 7905 1879 464 231 77.76 51.84 M MHH - - -	129	50	25		НННН			7880	1880	470	230	120
77.76 0.008 L MHMM 2089 485 240 59 $$ $$ 77.76 1.544 L MHHH $$ 7905 1879 464 200 77.76 19.44 L MHHM $$ 7905 1879 464 231 77.76 38.88 M MHMM $$ 7905 1879 464 231 77.76 38.88 M MHMM $$ 7905 1879 464 231 77.76 38.88 M MHMM $$ 7905 1879 464 231 77.76 51.84 M MHHM $$ 7905 1879 464 231 77.76 51.84 M MHH $$ 7905 1879 464 231 77.76 51.84 M MHH $$ 7905 1879 74 $$	130	50	50	Σ	HMLH			2770	1850	466	230	110
77.76 1.544 L MHMH 2.779 1362 335 83 N 77.76 2.048 L MHH 7905 1879 464 230 77.76 19.44 L MHM 7905 1879 464 231 77.76 38.38 M MHMH 7705 1879 464 231 77.76 38.38 M MHMH 7705 1879 464 231 77.76 58.18 M MHH 7905 1879 464 231 77.76 51.84 M MHH 7705 1879 464 231 77.76 55.36 M MHH 7905 1879 464 231 77.76 155.52 M MHH 7905 1879 464 231	131	77.76	0.008		MHMM	2089	485	240	59			
77.76 2.048 L MHHL $$ 6804 1626 402 200 1879 464 231 77.76 25 L MHHH $$ 7905 1879 464 231 77.76 255 L MHHH $$ 7905 1879 464 231 77.76 38.38 M MHHH $$ 7905 1879 464 231 77.76 51.34 M MHH $$ 7905 1879 464 231 77.76 51.34 M MHH $$ 7905 1879 464 231 77.76 51.34 M $$ 7905 1879 464 231 77.76 125 M MLH $$ 7905 1879 464 231 77.76 156.25 H MLH $$ 7905 1879 464	132	77.76	1.544	_	MHMH		2779	1362	335	83		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	133	77.76	2.048	_	MHHL		I	6804	1626	402	200	100
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	134	77.76	19.44	_	MHHM			7905	1879	464	231	115
77.76 34.368 M MHMM $$ $$ 6796 1626 402 200 77.76 38.88 M MHMH $$ $ 7905$ 1879 464 231 77.76 51.84 M MHH $$ 7905 1879 464 231 77.76 51.84 M MHH $$ 7905 1879 464 231 77.76 51.56 M MLLH $$ 7905 1879 464 231 77.76 155.52 H MLLH $$ 7905 1879 464 231 77.76 155.52 H MLM $$ 7905 1879 464 231 77.76 156.25 H MLM $$ 7905 1879 464 231 77.76 156.25 H MLM $$ -7905 1879 464 <td>135</td> <td>77.76</td> <td>25</td> <td></td> <td>НННМ</td> <td> </td> <td>2778</td> <td>1362</td> <td>335</td> <td>83</td> <td> </td> <td> </td>	135	77.76	25		НННМ		2778	1362	335	83		
77.76 38.88 M MHMH $$ $$ 7905 1879 464 231 231 77.76 41.736 M MHHL $$ $$ 6756 1623 402 200 200 77.76 51.84 M MHH $$ 2461 1208 298 74 $$ 77.76 55.536 M HLL $$ 7905 1879 464 231 77.76 125 M HLLM $$ -7905 1879 464 231 77.76 155.52 H MLM $$ -7905 1879 464 231 77.76 155.52 H MLM $$ -7905 1879 464 231 77.76 156.25 H MLM $$ $$ 7905 1879 464 231 77.76 161.328 H MLM	136	77.76	34.368	Σ	MHMM		1	6798	1626	402	200	100
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	137	77.76	38.88	Σ	MHMH			7905	1879	464	231	115
77.76 51.84 M MHHM $$ $$ 7905 1879 464 231 77.76 65.536 M MHHH $$ 2461 1208 298 74 $$ 77.76 77.76 77.76 125 M HLLM $$ 7905 1879 464 231 77.76 155.52 H MLH $$ $$ 7905 1879 464 231 77.76 155.52 H MLM $$ $$ 7905 1879 464 231 77.76 156.25 H MLM $$ $$ 7905 1879 464 231 77.76 311.04 H MLM $$ $$ $$ $$ $$ $$ $$ 77.76 311.04 H MLH $$ $$ $$ $$ $$ $$ $$ <td< td=""><td>138</td><td>77.76</td><td>44.736</td><td>M</td><td>MHHL</td><td> </td><td> </td><td>6756</td><td>1623</td><td>402</td><td>200</td><td>100</td></td<>	138	77.76	44.736	M	MHHL			6756	1623	402	200	100
	139	77.76	51.84	Σ	MHHM			7905	1879	464	231	115
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	140	77.76	65.536	Σ	ННН	I	2461	1208	298	74		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	141	77.76	77.76	M	HLLL			7905	1879	464	231	115
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	142	77.76	125	Σ	HLLM	5336	1220	602	148			
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	143	77.76	155.52	т	MLLH	I	I	7905	1879	464	231	115
77.76 161.1328 H MLMM 484 113	144	77.76	156.25	т	MLML	6003	1373	677	167			I
77.76 311.04 H MLMH 7905 1879 464 231 77.76 312.5 H MLHL 6003 1373 677 167 <	145	77.76	161.1328	т	MLMM	484	113					
77.76 312.5 H MLHL 6003 1373 677 167	146	77.76	311.04	т	MLMH			7905	1879	464	231	115
77.76 622.08 H MLHM 7905 1879 464 231 77.76 644.5313 H MLHH 484 113 <t< td=""><td>147</td><td>77.76</td><td>312.5</td><td>т</td><td>MLHL</td><td>6003</td><td>1373</td><td>677</td><td>167</td><td> </td><td> </td><td>I</td></t<>	147	77.76	312.5	т	MLHL	6003	1373	677	167			I
77.76 644.5313 H MLHH 484	148	77.76	622.08	т	MLHM			7905	1879	464	231	115
	149	77.76	644.5313	т	MLHH	484	113					

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lable 9.	гоок ир т	lable 9. Look Up lables for Clock Multiplication and Loop Bandwigth Settings (Continued)		נוטווכמנוטוו מ	וווט בטטף כנ) efilinac	OIIIIIIAA			
Plan #	fin	four	FRQTBL	FRQSEL		Loop	Loop Bandwidth Selection (Hz), BWSEL[1:0]	Selection (Hz), BWSE	:L[1:0]	
	(MHz)	(MHz)		[3:0]	L	ГН	ML	MM	HM	F	표
150	125	0.008		HLLL	1		7045	1681	415	207	103
151	125	1.544		HLLM	6741	1529	753	186			
152	125	2.048	_	НГГН	1299	303	150	1		I	
153	125	19.44		HLML	I		6551	1568	387	193	96
154	125	25		HLMM	1		7862	1870	462	230	115
155	125	34.368	Σ	НГГН	6722	1528	753	186		1	
156	125	38.88	Σ	HLML	6729	1529	753	186		I	
157	125	44.736	Δ	HLMM	1298	303	150		I		
158	125	51.84	Σ	HLMH		7988	3846	936	232	116	
159	125	65.536	Σ	HLHL	1298	303	150	1		I	
160	125	77.76	Σ	HLHM	6706	1528	753	186	1	I	
161	125	125	Σ	НГНН			7862	1870	462	230	115
162	125	155.52	т	MMLL	1298	303	150	I		I	
163	125	156.25	т	MMLM			7862	1870	462	230	115
164	125	161.1328	т	MMLH	1		7718	1839	454	226	113
165	125	311.04	т	MMML	1298	303	150	1		I	
166	125	312.5	т	MMMM	1		7862	1870	462	230	115
167	125	622.08	т	MMMH	1298	303	150	I	I	I	1
168	125	644.5313	т	MMHL			7718	1839	454	226	113
169	155.52	0.008		HLMH	2089	485	240	59	I	I	
170	155.52	1.544		HLHL		2779	1362	335	83	I	1
171	155.52	2.048		HLHM			7606	1809	447	223	111
172	155.52	19.44		НГНН	1		7905	1879	464	231	115
173	155.52	25		HMLL	1	2778	1362	335	83	1	1
174	155.52	77.76	т	MHMM			7905	1879	464	231	115
Notes: 1. F _{IN} 2. Si5	l and F _{OUT} fre 3315A suppor	equency value ts all frequen	es may be ro cy plans.	unded off. For	F _{IN} and F _{OUT} frequency values may be rounded off. For exact multiplication ratios, please contact Skyworks Solutions. Si5315A supports all frequency plans.	tion ratios, pl	lease contact	. Skyworks So	olutions.		
	inddns gollo	nt rrequency putting the second second pression of the second second second second second second second second	quency piaris	ans up to 125 MHz							

Table 9. Look Up Tables for Clock Multiplication and Loop Bandwidth Settings (Continued)

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ttings (Continued
Loop Bandwidth Se
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k Up Tables fo
Table 9. Lool

Plan #	f _{IN}	four	FRQTBL	FRQSEL		Loop	Bandwidth	Selection (Selection (Hz), BWSEL[1:0]	:L[1:0]	
	(MHz)	(MHz)		[3:0]	LM	Е	ML	MM	ΗМ	ЧГ	Ħ
175	155.52	125	т	HHMM	5336	1220	602	148	I	I	I
176	155.52	155.52	т	MHLL		I	7905	1879	464	231	115
177	155.52	156.25	т	MHLM	6003	1373	677	167	I	I	I
178	155.52	161.1328	т	MHLH	484	113	I	I	I	I	I
179	155.52	311.04	т	MHML		I	7905	1879	464	231	115
180	155.52	312.5	т	MHMM	6003	1373	677	167	I		I
181	155.52	622.08	т	HMHM	I	I	7905	1879	464	231	115
182	155.52	644.5313	т	MHHL	828	193	95	I	I	I	I
183	156.25	0.008	_	HMLM	I	I	6123	1469	363	181	06
184	156.25	1.544	_	HMLH	1627	379	187	I	I	I	I
185	156.25	2.048	_	HMML	322	75	I	I	I	I	I
186	156.25	19.44		HMMM		1	4852	1172	290	145	72
187	156.25	25	_	HMMH	I	I	7835	1864	460	229	114
188	156.25	77.76	т	MHHM	1625	379	187	I	I	I	I
189	156.25	125	т	HHHM		I	7835	1864	460	229	114
190	156.25	155.52	т	HLLL	322	75	I	I	I	I	I
191	156.25	156.25	т	HLLM	I	I	7835	1864	460	229	114
192	156.25	161.1328	т	НГГН	l	I	7718	1839	454	226	113
193	156.25	311.04	т	HLML	322	75	I	I	I	I	I
194	156.25	312.5	т	HLMM		I	7835	1864	460	229	114
195	156.25	622.08	т	HLMH	322	75	I	I	I	I	I
196	156.25	644.5313	т	HLHL	I	I	7718	1839	454	226	113
197	161.1328	0.008		HMHL	225	1					1
198	161.1328	1.544	_	MHMH	151	I	I	I	I	I	I
199	161.1328	2.048		НМНН	225	I	I	I	I	I	I
Notes: 1. F _{IN} 2. Sič 3. Sič	₄ and F _{OUT} fre 5315A suppor 5315B suppor	equency value ts all frequenc ts output frequ	es may be rou sy plans. uency plans i	F _{IN} and F _{OUT} frequency values may be rounded off. For exact multiplication ratios, please contact Skyworks Solutions. Si5315A supports all frequency plans. Si5315B supports output frequency plans up to 125 MHz.	xact multiplica	tion ratios, p	lease contac	t Skyworks S	olutions.		

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 27

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Settings (
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Iltiplication	
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p Tables fo	
9. Look Up	
Table (

	able V. FOON OP Tables IN CIOCN								_		
Plan #	fin	four	FRQTBL	FRQSEL		Loop	Loop Bandwidth Selection (Hz), BWSEL[1:0]	Selection ((Hz), BWSE	L[1:0]	
	(ZHM)	(MHz)		[3:0]	ΓW	Ч	МΓ	MM	ΗM	F	포
200	161.1328	19.44		HHLL	679	159	78			1	
201	161.1328	25		HHLM	678	159	78			1	
202	161.1328	77.76	т	HLHM	678	159	78	I	I	I	I
203	161.1328	125	Н	НГНН			7179	1721	426	212	106
204	161.1328	156.25	т	HMLL			7019	1683	416	207	103
205	161.1328	161.1328	т	HMLM	332	78			I	1	
206	161.1328	312.5	т	HMML	3873	892	440	109	I	I	
207	161.1328	644.5313	т	HMMM	151			I	I	1	1
208	644.5313	0.008		ННСН	880	206	101	1	I	1	
209	644.5313	1.544		HHML	413	96		I		I	I
210	644.5313	2.048	_	MMHH		3373	1650	405	101	I	1
211	644.5313	19.44		НМНН		3641	1779	437	108	1	
212	644.5313	25	_	HHHL			7886	1875	463	231	115
213	644.5313	77.76	т	НММН	828	193	95	I	I	1	1
214	644.5313	125	т	HMHL			7732	1840	454	226	113
215	644.5313	155.52	т	МНМН	828	193	95		I	I	
216	644.5313	156.25	т	НМНН			7732	1840	454	226	113
217	644.5313	161.1328	т	HHLL			7895	1880	464	231	115
218	644.5313	311.04	т	HHLM	828	193	95				I
219	644.5313	312.5	т	ННСН	206					1	
220	644.5313	622.08	т	HHML	120				I	1	
221	644.5313	644.5313	т	MMHH			7895	1880	464	231	115
Notes: 1. F _{IN} 2. Si5 3. Si5	F _{IN} and F _{OUT} frequency values may b Si5315A supports all frequency plans. Si5315B supports output frequency pl	equency value ts all frequenc ts output frequ	es may be ro y plans. uency plans	F _{IN} and F _{OUT} frequency values may be rounded off. For ε Si5315A supports all frequency plans. Si5315B supports output frequency plans up to 125 MHz.	e rounded off. For exact multiplication ratios, please contact Skyworks Solutions. ans up to 125 MHz.	ation ratios, p	lease contact	Skyworks S	olutions.		

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5.2. PLL Self-Calibration

An internal self-calibration (ICAL) is performed before operation to optimize loop parameters and jitter performance. While the self-calibration is being performed, the DSPLL is being internally controlled by the self-calibration state machine. The LOL alarm will be active during ICAL. The self-calibration time t_{LOCKHW} is given in Table 3, "AC Characteristics".

Any of the following events will trigger a self-calibration:

- Power-on-reset (POR)
- Release of the external reset pin RST (transition of RST from 0 to 1)
- Change in FRQSEL, FRQTBL, BWSEL, or XTAL/CLOCK pins
- Internal DSPLL registers out-of-range, indicating the need to relock the DSPLL

In any of the above cases, an internal self-calibration will be initiated if a valid input clock exists (no input alarm) and is selected as the active clock at that time. The external crystal or reference clock must also be present for the self-calibration to begin. If valid clocks are not present, the self-calibration state machine will wait until they appear, at which time the calibration will start. An output clock will be active while waiting for a valid input clock. The output clock frequency is based on the VCO range determine by FRQSEL and FRQTBL settings. This output clock will vary by $\pm 20\%$. If no output clock is desired prior to an ICAL, then the SFOUT pins should be kept at LM for 1.2 seconds until the output clock is stable.

After a successful self-calibration has been performed with a valid input clock, no subsequent self calibrations are performed unless one of the above conditions are met. If the input clock is lost following self-calibration, the device enters holdover mode. When the input clock returns, the device relocks to the input clock without performing a self-calibration.

5.2.1. Input Clock Stability during Internal Self-Calibration

An exit from reset must occur when the selected CKINn clock is stable in frequency with a frequency value that is within the device operating range. The other CKINs must also either be stable in frequency or squelched during a reset.

5.2.2. Self-Calibration caused by Changes in Input Frequency

If the selected CKINn varies by 500 ppm or more in frequency since the last calibration, the device may initiate a self-calibration.

5.2.3. Device Reset

Upon powerup, the device internally executes a power-on-reset (POR) which resets the internal device logic. The pin RST can also be used to initiate a reset. The device stays in this state until a valid CKINn is present, when it then performs a PLL Self-Calibration (See 5.2. "PLL Self-Calibration").

5.2.4. Recommended Reset Guidelines

Follow the recommended RESET guidelines in Table 10 when reset should be applied to a device.

Pin #	Si5315 Pin Name	Must Reset after Changing
2	FRQTBL	Yes
11	XTAL/CLOCK	Yes
22	BWSEL0	Yes
23	BWSEL1	Yes
24	FRQSEL0	Yes
25	FRQSEL1	Yes
26	FRQSEL2	Yes
27	FRQSEL3	Yes

Table 10. Si5315 Pins and Reset

5.2.5. Hitless Switching with Phase Build-Out

Skyworks Solutions switching technology performs "phase build-out" to minimize the propagation of phase transients to the clock outputs during input clock switching. All switching between input clocks occurs within the input multiplexor and phase detector circuitry. The phase detector circuitry continually monitors the phase difference between each input clock and the DSPLL output clock, f_{OSC} . The phase detector circuitry can lock to a clock signal at a specified phase offset relative to f_{OSC} so that the phase offset is maintained by the PLL circuitry.

At the time a clock switch occurs, the phase detector circuitry knows both the input-to-output phase relationship for the original input clock and for the new input clock. The phase detector circuitry locks to the new input clock at the new clock's phase offset so that the phase of the output clock is not disturbed. The phase difference between the two input clocks is absorbed in the phase detector's offset value, rather than being propagated to the clock output.

The switching technology virtually eliminates the output clock phase transients traditionally associated with clock rearrangement (input clock switching). The Maximum Time Interval Error (MTIE) and maximum slope for clock output phase transients during clock switching are given in (Table 3, "AC Characteristics"). These values fall significantly below the limits specified in the ITU-T G.8262, Telcordia GR-1244-CORE, and GR-253-CORE requirements.

5.3. Input Clock Control

This section describes the clock selection capabilities (manual input selection, automatic input selection, hitless switching, and revertive switching). When switching between two clocks, LOL may temporarily go high if the two clocks differ in frequency by more than 100 ppm.

5.3.1. Manual Clock Selection

Manual control of input clock selection is chosen via the CS_CA pin according to Table 11 and Table 12.

AUTOSEL	Clock Selection Mode
L	Manual
М	Automatic non-revertive
Н	Automatic revertive

Table 11. Automatic/Manual Clock Selection

Table 12. Manual Input Clock Selection, AUTOSEL = L

CS_CA	Si5315 AUTOSEL = L
0	CKIN1
1	CKIN2

5.3.2. Automatic Clock Selection

The AUTOSEL input pin sets the input clock selection mode as shown in Table 11. Automatic switching is either revertive or non-revertive. Setting AUTOSEL to M or H, changes the CS_CA pin to an output pin that indicates the state of the automatic clock selection.

Table 13. Clock Active Indicators,	AUTOSEL = M or H
------------------------------------	------------------

CS_CA	Active Clock
0	CKIN1
1	CKIN2

The prioritization of clock inputs for automatic switching is shown in Table 14. This priority is hardwired in the devices.

Priority	Input Clocks
1	CKIN1
2	CKIN2
3	Holdover

Table 14.	Input Clock Priorit	y for Auto Switching
-----------	---------------------	----------------------

At power-on or reset, the valid CKINn with the highest priority (1 being the highest priority) is automatically selected. If no valid CKINn is available, the device suppresses the output clocks and waits for a valid CKINn signal.

If the currently selected CKINn goes into an alarm state, the next valid CKINn in priority order is selected. If no valid CKINn is available, the device enters holdover.

Operation in revertive and non- revertive is different when a signal becomes valid:

Revertive (AUTOSEL = H):The device constantly monitors all CKINn. If a CKINn with a higher priority than
the current active CKINn becomes valid, the active CKINn is changed to the
CKINn with the highest priority.Non-revertive (AUTOSEL = M):The active clock does not change until there is an alarm on the active clock. The
device will then select the highest priority CKINn that is valid. Once in holdover,

the device will switch to the first CKINn that becomes valid.

5.4. Alarms

Summary alarms are available to indicate the overall status of the input signals. Alarm outputs stay high until all the alarm conditions for that alarm output are cleared.

5.4.1. Loss-of-Signal

The device has loss-of-signal circuitry that continuously monitors CKINn for missing pulses. The LOS circuitry generates an internal LOSn_INT output signal that is processed with other alarms to generate LOS1 and LOS2.

An LOS condition on CKIN1 causes the internal LOS1_INT alarm to become active. Similarly, an LOS condition on CKINn causes the LOSn_INT alarm to become active. Once a LOSn_INT alarm is asserted on one of the input clocks, it remains asserted until that input clock is validated over a designated time period. The time to clear LOSn_INT after a valid input clock appears is listed in Table 3, "AC Characteristics". If another error condition on the same input clock is detected during the validation time then the alarm remains asserted and the validation time starts over.

5.4.1.1. LOS Algorithm

The LOS circuitry divides down each input clock to produce an 8 kHz to 2 MHz signal. The LOS circuitry over samples this divided down input clock using a 40 MHz clock to search for extended periods of time without input clock transitions. If the LOS monitor detects twice the normal number of samples without a clock edge, a LOSn_INT alarm is declared. Table 3, "AC Characteristics" gives the minimum and maximum amount of time for the LOS monitor to trigger.

5.4.1.2. Lock Detect

The PLL lock detection algorithm indicates the lock status on the LOL output pin. The algorithm works by continuously monitoring the phase of the input clock in relation to the phase of the feedback clock. If the time between two consecutive phase cycle slips is greater than the retrigger time, the PLL is in lock. The LOL output has a guaranteed minimum pulse width as shown in (Table 3, "AC Characteristics"). The LOL pin is also held in the active state during an internal PLL calibration. The retrigger time is automatically set based on the PLL closed loop bandwidth (See Table 15).

PLL Bandwidth Setting (BW)	Retrigger Time (ms)
60–120 Hz	53
120–240 Hz	26.5
240–480 Hz	13.3
480–960 Hz	6.6
960–1920 Hz	3.3
1920–3840 Hz	1.66
3840–7680 Hz	0.833

Table 15. Lock Detect Retrigger Time	Table 1	Lock Detect	Retrigger	Time
--------------------------------------	---------	-------------	-----------	------

5.5. Holdover Mode

If an LOS condition exists on the selected input clock, the device enters holdover. In this mode, the device provides a stable output frequency until the input clock returns and is validated. When the device enters holdover, the internal oscillator is initially held to its last frequency value. Next, the internal oscillator slowly transitions to a historical average frequency value that was taken over a time window of 6,711 ms in size that ended 26 ms before the device entered holdover. This frequency value is taken from an internal memory location that keeps a record of previous DSPLL frequency values. By using a historical average frequency, input clock phase and frequency transients that may occur immediately preceding loss of clock or any event causing holdover do not affect the holdover frequency. Also, noise related to input clock jitter or internal PLL jitter is minimized.

If a highly stable reference, such as an oven-controlled crystal oscillator, is supplied at XA/XB, an extremely stable holdover can be achieved. If a crystal is supplied at the XA/XB port, the holdover stability will be limited by the stability of the crystal; Table 3, "AC Characteristics" gives the specifications related to the holdover function.

5.5.1. Recovery from Holdover

When the input clock signal returns, the device transitions from holdover to the selected input clock. The device performs hitless recovery from holdover. The clock transition from holdover to the returned input clock includes "phase buildout" to absorb the phase difference between the holdover clock phase and the input clock phase. See Table 3, "AC Characteristics" for specifications.

5.6. PLL Bypass Mode

The Si5315 supports a PLL bypass mode in which the selected input clock is fed directly to both enabled output buffers, bypassing the DSPLL. Internally, the bypass path is implemented with high-speed differential signaling; however, this path is not a low jitter path and will see significantly higher jitter on CKOUT. In PLL bypass mode, the input and output clocks will be at the same frequency. PLL bypass mode is useful in a laboratory environment to measure system performance with and without the jitter attenuation provided by the DSPLL. The DSBL2_BY pin is used to select the PLL Bypass Mode according to Table 16. Bypass mode is not supported for CMOS clock outputs (SFOUT = LH).

DSBL2/BYPASS	Function
L	CKOUT2 Enabled
М	CKOUT2 Disabled
Н	PLL Bypass Mode w/ CKOUT2 Enabled

Table 16. DSBL2/BYPASS Pin Settings

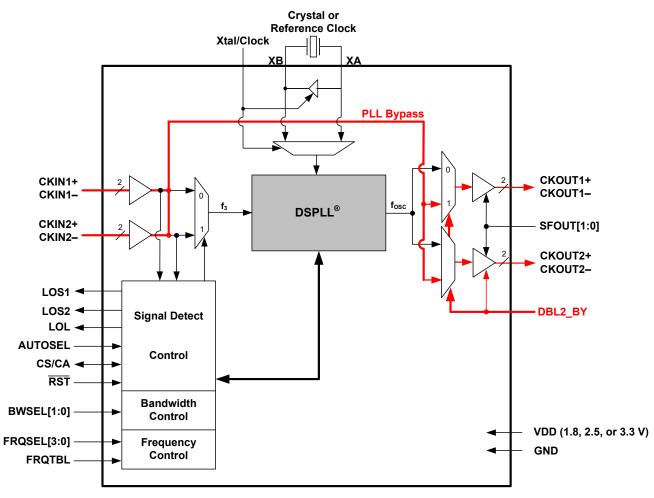


Figure 10. Bypass Signal

6. High-Speed I/O

6.1. Input Clock Buffers

The Si5315 provides differential inputs for the CKINn clock inputs. These inputs are internally biased to a common mode voltage [see Table 2, "DC Characteristics"] and can be driven by either a single-ended or differential source. Figure 11 through Figure 14 show typical interface circuits for LVPECL, CML, LVDS, or CMOS input clocks. Note that the jitter generation improves for higher levels on CKINn (within the limits in Table 3, "AC Characteristics").

AC coupling the input clocks is recommended because it removes any issue with common mode input voltages. However, either ac or dc coupling is acceptable. Figures 11 and 12 show various examples of different input termination arrangements. Unused inputs can be left unconnected.

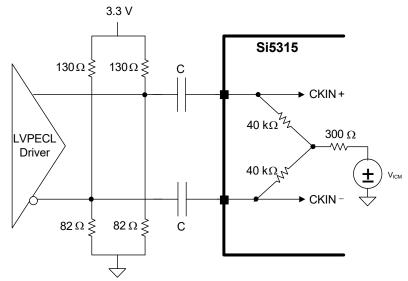


Figure 11. Differential LVPECL Termination

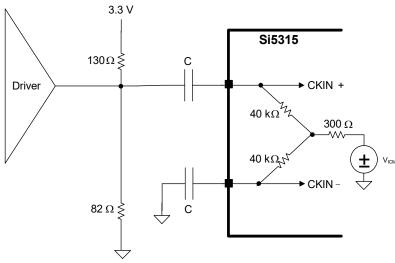


Figure 12. Single-ended LVPECL Termination

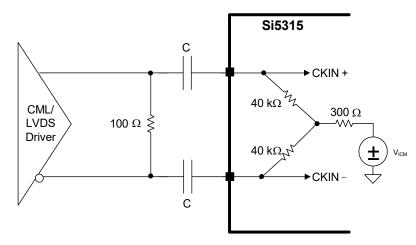
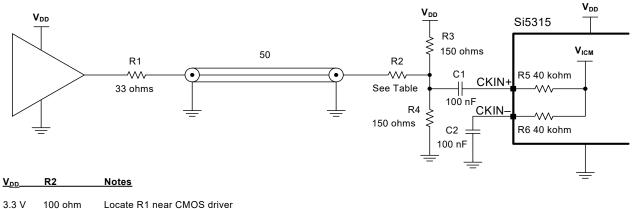


Figure 13. CML/LVDS Termination (1.8, 2.5, 3.3 V)





2.5 V 49.9 ohm Locate other components near Si5317

1.8 V 14.7 ohm Recalculate resistor values for other drive strengths

Additional Notes:

1. Attenuation circuit limits overshoot and undershoot.

2. Not to be used with non-square wave input clocks.

Figure 14. CMOS Termination (1.8, 2.5, 3.3 V)

6.2. Output Clock Drivers

The Si5315 has a flexible output driver structure that can drive a variety of loads, including LVPECL, LVDS, CML, and CMOS formats. The signal format is selected for both CKOUT1 and CKOUT2 outputs using the SFOUT [1:0] pins. This modifies the output common mode and differential signal swing. See Table 2, "DC Characteristics" for output driver specifications. The SFOUT [1:0] pins are three-level input pins, with the states designated as L (ground), M (V_{DD}/2), and H (V_{DD}). Table 17 shows the signal formats based on the supply voltage and the type of load being driven.

SFOUT[1:0]	Signal Format
HL	CML
HM	LVDS
LH	CMOS
LM	Disabled
МН	LVPECL
ML	Low-swing LVDS
All Others	Reserved

Table 17. Output Signal Format Selection (SFOUT)

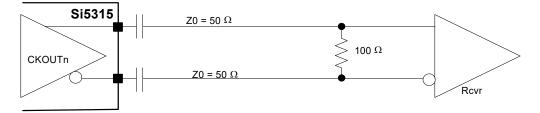


Figure 15. Typical Differential Output Circuit

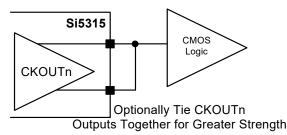
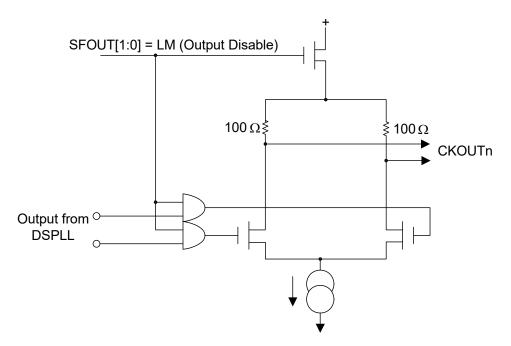


Figure 16. Typical CMOS Output Circuit (Tie CKOUTn+ and CKOUTn– Together)

For the CMOS setting (SFOUT = LH), both output pins drive single-ended in-phase signals. The CKOUT+/- can be externally shorted together for greater drive strength specified in Table 2, "DC Characteristics".

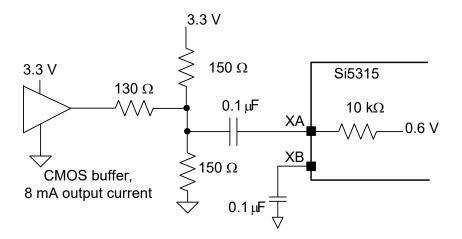




The SFOUT [1:0] pins can also be used to disable both outputs. Disabling the output puts the CKOUTn+ and CKOUTn– pins in a high-impedance state relative to V_{DD} (common mode tri-state) while the two outputs remain connected to each other through a 200 Ω on-chip resistance (differential impedance of 200 Ω). The maximum amount of internal circuitry is powered down, minimizing power consumption and noise generation. Recovery from the disable mode requires additional time as specified in Table 3, "AC Characteristics".

7. Crystal/Reference Clock Input

The device can use an external crystal or external clock as a reference. If an external clock is used, it must be ac coupled. With appropriate buffers, the same external reference clock can be applied to CKINn. Although the reference clock input can be driven single ended (See Figure 18), the best performance is with a crystal or low jitter, differential clock source. No external loading capacitors are required for normal crystal operation.



For 2.5 V operation, change 130 Ω to 82 Ω .



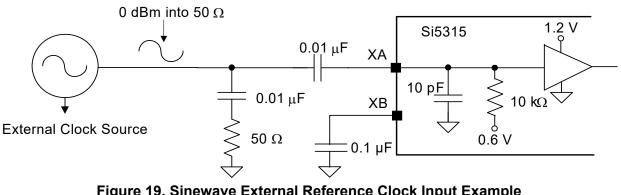
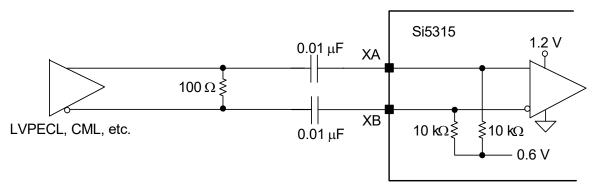


Figure 19. Sinewave External Reference Clock Input Example





7.1. Crystal/Reference Clock Selection

The Si5315 requires either a low-jitter external oscillator or a low-cost fundamental mode crystal to be connected to its XA/XB pins. This serves both as a jitter reference for jitter attenuation and as a reference oscillator for stability during holdover. The frequency the reference is not directly related to either the input or the output clock frequencies. The range of the reference frequency is from 37 to 41 MHz. For recommendations on the selection of the reference frequency and a list of approved crystals, see the application note AN591 which can be downloaded from https://www.skyworksinc.com/en/Products/Timing.

In holdover, the DSPLL remains locked to this external reference. Any changes in the frequency of this reference when the DSPLL is in holdover will be tracked by the output of the device. Note that crystals can have temperature sensitivities. Table 18 shows how the XTAL/CLOCK pin is used to select between a crystal and an external oscillator.

XTAL/CLOCK	Туре
М	37–41 MHz external clock
L	40 MHz crystal

Table 18. XA/XB Reference Sources

Because the crystal is used as a jitter reference, rapid changes of the crystal temperature can temporarily disturb the output phase and frequency. For example, it is recommended that the crystal not be placed close to a fan that is being turned off and on. If a situation such as this is unavoidable, the crystal should be thermally isolated with an insulating cover.

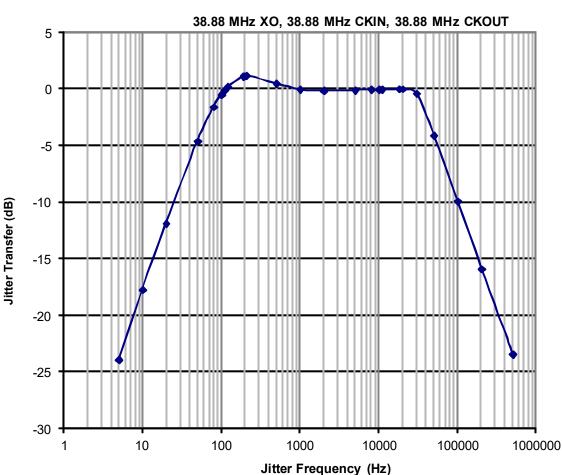
7.1.1. Reference Drift

During holdover, long-term and temperature related drift of the reference input result in a one-to-one drift of the output frequency. That is, the stability of the any-frequency output is identical to the drift of the reference frequency. This means that for the most demanding applications where the drift of a crystal is not acceptable, an external temperature compensated or ovenized oscillator will be required. Drift is not an issue unless the part is in holdover. Also, the initial accuracy of the reference oscillator (or crystal) is not relevant.

7.1.2. Reference Jitter

Jitter on the reference input has a roughly one-to-one transfer function to the output jitter over the bandwidth ranging from 100 Hz up to 30 kHz. If a crystal is used on the XA/XB pins, the reference will have low jitter if a suitable crystal is in use. If the XA/XB pins are connected to an external reference oscillator, the jitter of the external reference oscillator may contribute significantly to the output jitter.

A typical reference input-to-output jitter transfer function is shown in Figure 21.



Jitter Transfer XA/XB Reference to CKOUT

Figure 21. Typical XA/XB Reference Jitter Transfer Function

8. Power Supply Filtering

This device incorporates an on-chip voltage regulator with excellent PSRR to power the device from a supply voltage of 1.8, 2.5, or 3.3 V. The device requires minimal supply decoupling and no stringent layout or ground plane islands. Internal core circuitry is driven from the output of this regulator while I/O circuitry uses the external supply voltage directly. Table 3, "AC Characteristics" gives the sensitivity of the on-chip oscillator to changes in the supply voltage. Refer to the Si5315 evaluation board for an example.

The center ground pad under the device must be electrically and thermally connected to the ground plane. See Figure 26, "Ground Pad Recommended Layout," on page 50.

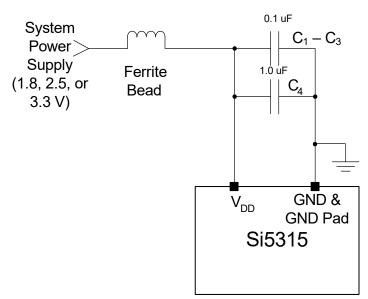


Figure 22. Typical Power Supply Bypass Network

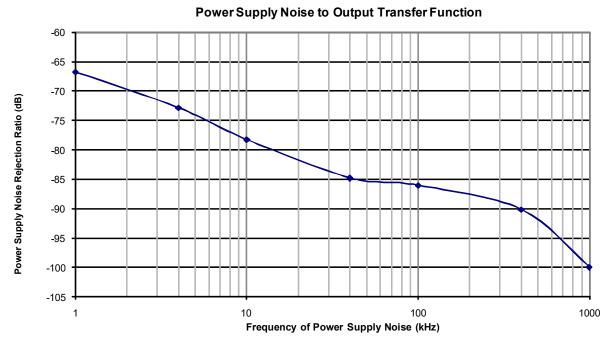
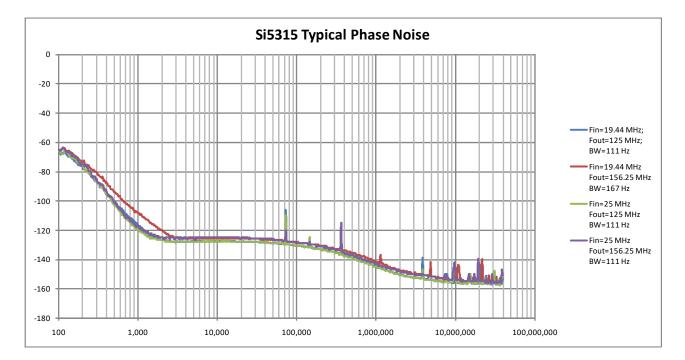


Figure 23. Fout = 155 MHz with 112 Hz Loop Bandwidth, 100 mVp-p Supply Noise

9. Typical Phase Noise Plots

The following is a typical phase noise plot. The clock input source was a Rohde and Schwarz model SML03 RF Generator. The spectrum analyzer was either an Agilent model E5052B, model E4400A or model JS-500. The Si5315 operates at 3.3 V with an ac coupled differential PECL output and an ac coupled differential sine wave input from the RF generator at 0 dBm. Note that, as with any PLL, the output jitter that is below the loop BW is caused by the jitter at the input clock, not the Si5315. Except as noted, loop BWs of 60 to 240 Hz were in use.

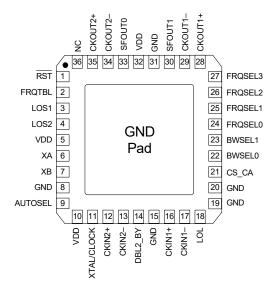
9.1. 10G LAN SyncE Example



		Frequen	cy Plan	
	Fin=19.44 MHz Fout=156.25 MHz BW=167 Hz	Fin=19.44 MHz Fout=125 MHz BW=111 Hz	Fin=25 MHz Fout=156.25 MHz BW=111 Hz	Fin=25 MHz Fout=125 MHz BW=111 Hz
Jitter Integration Filter Band		RMS Jit	tter (fs)	
IEEE802.3 (1.875 to 20 MHz)	232	240	251	240
SONET OC-192 (20 kHz to 80 MHz)	483	575	525	550
SONET OC-192 (4 to 80 MHz)	302	303	300	294
SONET OC-192 (50 kHz to 80 MHz)	467	564	510	537
SONET OC-48 (12 kHz to 20 MHz)	470	565	517	541
SONET OC-3 (12 kHz to 5 MHz)	422	524	471	503
BroadBand (800 Hz to 80 MHz)	511	584	533	557

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10. Pin Descriptions: Si5315



Pin assignments are preliminary and subject to change.

Pin #	Pin Name	I/O	Signal Level	Description
1	RST	I	LVCMOS	External Reset.
				Active low input that performs external hardware reset of device. Resets all internal logic to a known state. Clock out- puts are tristated during reset. After rising edge of RST sig- nal, the Si5315 will perform an internal self-calibration when a valid input signal is present. This pin has a weak pull-up.
2	FRQTBL	I	3-Level	Frequency Table Select.
				Selects frequency table. (Table 9 on page 20.)
				This pin has a weak pull-up and weak pull-down and defaults to M.
				Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
3	LOS1	0	LVCMOS	CKIN1 Loss of Signal.
				Active high loss-of-signal indicator for CKIN1. Once trig- gered, the alarm will remain active until CKIN1 is validated. 0 = CKIN1 present 1 = LOS on CKIN1
4	LOS2	0	LVCMOS	CKIN2 Loss of Signal.
				Active high loss-of-signal indicator for CKIN2. Once trig- gered, the alarm will remain active until CKIN2 is validated. 0 = CKIN2 present 1 = LOS on CKIN2

Table 19. Si5315 Pin Descriptions

Pin #	Pin Name	I/O	Signal Level	Description
5, 10, 32	V _{DD}	V _{DD}	Supply	$\label{eq:supply} \begin{array}{l} \textbf{Supply.} \\ The device operates from a 1.8, 2.5, or 3.3 V supply. Bypass capacitors should be associated with the following V_{DD} pins: \\ 5 & 0.1 \ \mu F \\ 10 & 0.1 \ \mu F \\ 32 & 0.1 \ \mu F \\ A 1.0 \ \mu F \ should also be placed as close to device as is practical. \\ \end{array}$
7 6	XB XA	Ι	Analog	External Crystal or Reference Clock. External crystal should be connected to these pins to use internal oscillator based reference. Crystal or reference clock selection is set by the XTAL/CLOCK pin.
8, 15,19, 20,31	GND	GND	Supply	Ground. Must be connected to system ground. Minimize the ground path impedance for optimal performance of this device.
9	AUTOSEL	I	3-Level	Manual/Automatic Clock Selection. Three level input that selects the method of input clock selec- tion to be used. L = Manual M = Automatic non-revertive H = Automatic revertive This pin has a weak pull-up and weak pull-down and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
11	XTAL/CLOCK	Ι	3-Level	External Crystal or Reference Clock Rate. Three level input that selects the type and rate of external crystal or reference clock to be applied to the XA/XB port. This pin has both a weak pull-up and a weak pull-down and defaults to M. L = Crystal M = Clock (Default) H = Reserved Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
12 13	CKIN2+ CKIN2–	Ι		Clock Input 2. Differential input clock. This input can also be driven with a single-ended signal. Input frequency selected from a table of values. The same frequency must be applied to CKIN1 and CKIN2.

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Pin #	Pin Name	I/O	Signal Level	Description
14	DBL2_BY	1	3-Level	Output 2 Disable/Bypass Mode Control. Controls enable of CKOUT2 divider/output buffer path and PLL bypass mode. L = CKOUT2 enabled M = CKOUT2 disabled H = Bypass mode with CKOUT2 enabled. Bypass mode is not supported with CMOS clock outputs (SFOUT = LH). This pin has a weak pull-up and weak pull-down and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
16 17	CKIN1+ CKIN1–	1	Multi	Clock Input 1. Differential input clock. This input can also be driven with a single-ended signal. Input frequency selected from a table of values. The same frequency must be applied to CKIN1 and CKIN2.
18	LOL	0	LVCMOS	 PLL Loss of Lock Indicator. This pin functions as the active high PLL loss of lock indicator. 0 = PLL locked 1 = PLL unlocked
21	CS_CA	I/O	LVCMOS	 Input Clock Select/Active Clock Indicator. Input: If manual clock selection mode is chosen (AUTOSEL = L), this pin functions as the manual input clock selector. This input is internally deglitched to prevent inadvertent clock switching during changes in the CS input state. 0 = Select CKIN1 1 = Select CKIN2 If configured as input, must be set high or low. Output: If automatic clock selection mode is chosen (AUTOSEL = M or H), this pin indicates which of the two input clocks is currently the active clock. If alarms exist on both CKIN1 and CKIN2, indicating that the holdover state has been entered, CA will indicate the last active clock that was used before entering the hold state. 0 = CKIN1 active input clock 1 = CKIN2 active input clock
23 22	BWSEL1 BWSEL0	Ι	3-Level	Loop Bandwidth Select. Three level inputs that select the DSPLL closed loop band- width. See Table 9 on page 20 for available settings. These pins have both weak pull-ups and weak pull-downs and default to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.

Table 19	. Si5315	Pin	Descriptions	(Continued)
----------	----------	-----	--------------	-------------

Pin #	Pin Name	I/O	Signal Level		Des	cription	
27	FRQSEL3	I	3-Level	Frequency	Select.		
26	FRQSEL2					t the input clock and clock	k multi-
25	FRQSEL1			plication ratio, depending on the FRQTBL setting.			
24	FRQSEL0			These pins and default		pull-ups and weak pull-do	wns
						an external resistor voltag ctive device that will tri-sta	
29	CKOUT1-	0	Multi	Clock Outp	out 1.		
28	CKOUT1+			table of valu pins. Outpu patible mod	ues. Output signa it is differential fo	a frequency selected from al format is selected by SF r LVPECL, LVDS, and CN prmat, both output pins dri outputs.	OUT IL com-
33	SFOUT0	I	3-Level	Signal For	mat Select.		
30	SFOUT1				voltage and diffe	t the output signal format rential swing) for both CK	
					SFOUT[1:0]	Signal Format	
					НН	Reserved	
					НМ	LVDS	
					HL	CML	
				МН	LVPECL		
					MM	Reserved	
					ML	LVDS—Low Swing	
					LH	CMOS	
					LM	Disable	
					LL	Reserved	
				and default Some desig	to M. gns may require a	pull-ups and weak pull-do an external resistor voltag ctive device that will tri-sta	e
34	CKOUT2-	0	Multi	Clock Outp	out 2.		
35	CKOUT2+			table of valu pins. Outpu patible mod	ues. Output signa it is differential fo	a frequency selected fror al format is selected by SF r LVPECL, LVDS, and CN prmat, both output pins dri outputs.	OUT IL com-
36	NC	_		No Connec	ct.		
				Leave floati normal ope		ernal connections to this p	oin for
GND	GND	GND	Supply	Ground Pa	d.		
PAD					l pad must provid to a ground plan	le a low thermal and elect e.	rical

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Pin #	Si5315	Pull
1	RST	U
2	FRQTBL	U, D
9	AUTOSEL	U, D
11	XTAL/ CLOCK	U, D
14	DBL2_BY	U, D
21	CS_CA	U, D
22	BWSEL0	U, D
23	BWSEL1	U, D
24	FRQSEL0	U, D
25	FRQSEL1	U, D
26	FRQSEL2	U, D
27	FRQSEL3	U, D
30	SFOUT1	U, D
33	SFOUT0	U, D

Table 20. Si5315 Pull-Up/Pull-Down

11. Ordering Guide

Ordering Part Number	Output Clock Freq Range	Pkg	ROHS6, Pb-Free	Temp Range
Si5315A-C-GM	8 kHz–644.53 MHz	36-Lead 6x6 mm QFN	Yes	–40 to 85 °C
Si5315B-C-GM	8 kHz–125 MHz	36-Lead 6x6 mm QFN	Yes	–40 to 85 °C
Si5315-EVB	8 kHz–644.53 MHz	Evaluation Board		
Note: Add an "R" at the	end of the device to denote t	ape and reel options (i.e.	, Si5315A-C-GMR)	

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12. Package Outline: 36-Pin QFN

Figure 24 illustrates the package details for the Si5315. Table 21 lists the values for the dimensions shown in the illustration.

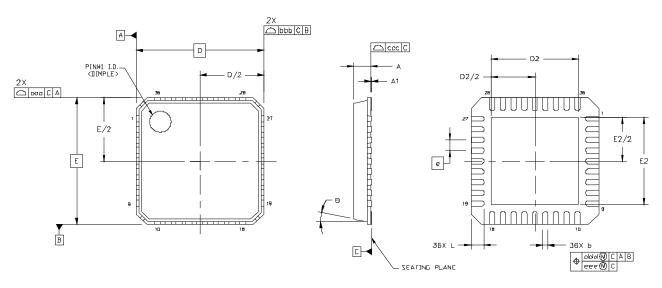


Figure 24. 36-Pin Quad Flat No-Lead (QFN)

Symbol	Millimeters			Symbol	Millimeters		
	Min	Nom	Max		Min	Nom	Ма
А	0.80	0.85	0.90	L	0.50	0.60	0.7
A1	0.00	0.02	0.05	θ	—	—	12
b	0.18	0.25	0.30	aaa	—	—	0.1
D	6.00 BSC			bbb	_	—	0.1
D2	3.95	4.10	4.25	CCC	_	—	0.0
е	0.50 BSC			ddd	—	—	0.1
E	6.00 BSC			eee	_	—	0.0
E2	3.95	4.10	4.25			I	1

Table 21. Package Dimensions

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.

3. This drawing conforms to JEDEC outline MO-220, variation VJJD.

4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

13. PCB Land Pattern

Figure 25 illustrates the PCB land pattern for the Si5315. Figure 26 illustrates the recommended ground pad layout. Table 22 lists the land pattern dimensions.

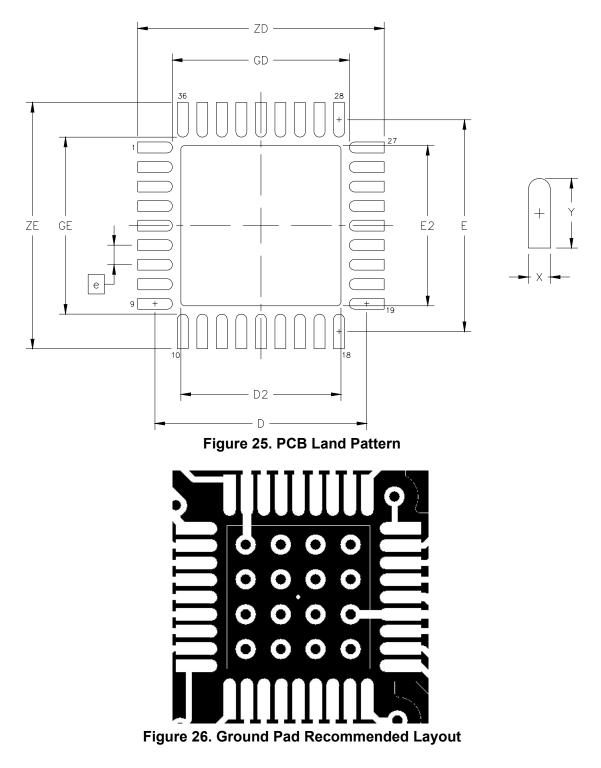


Table 22. PC	B Land Pattern	Dimensions
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Dimension	Min	Мах
е	0.50 BSC.	
E	5.42 REF.	
D	5.42 REF.	
E2	4.00	4.20
D2	4.00	4.20
GE	4.53	—
GD	4.53	—
Х	_	0.28
Y	0.89 REF.	
ZE	—	6.31
ZD	_	6.31

Notes (General):

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- **2.** Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
- 3. This Land Pattern Design is based on IPC-SM-782 guidelines.

4. All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a Fabrication Allowance of 0.05 mm.

Notes (Solder Mask Design):

1. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.

Notes (Stencil Design):

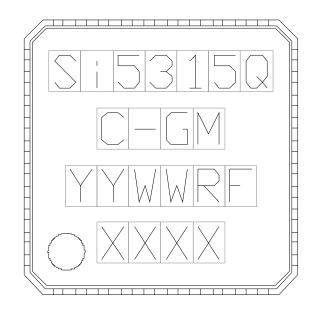
- **1.** A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 2. The stencil thickness should be 0.125 mm (5 mils).
- 3. The ratio of stencil aperture to land pad size should be 1:1 for the perimeter pads.
- **4.** A 4 x 4 array of 0.80 mm square openings on 1.05 mm pitch should be used for the center ground pad.

Notes (Card Assembly):

- 1. A No-Clean, Type-3 solder paste is recommended.
- The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

14. Top Marking

14.1. Si5315 Top Marking (QFN)



14.2. Top Marking Explanation

Mark Method:	Laser	
Font Size:	0.80 mm Right-Justified	
Line 1 Marking:	Si5315Q	Customer Part Number Q = Speed Code: A, B See Ordering Guide for options.
Line 2 Marking:	C-GM	C = Product Revision G = Temperature Range –40 to 85 °C (RoHS6) M = QFN Package
Line 3 Marking:	YYWWRF	YY = Year WW = Work Week R = Die Revision F = Internal code Assigned by the Assembly House. Corresponds to the year and work week of the mold date.
Line 4 Marking:	Pin 1 Identifier	Circle = 0.75 mm Diameter Lower-Left Justified
	XXXX	Internal Code

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DOCUMENT CHANGE LIST

Revision 0.1 to Revision 0.2

 Expanded/added numerous operating sections to initial data sheet

Revision 0.2 to Revision 0.25

- Updated features and application list
- Updated Section 1. "Electrical Specifications"
- Added voltage regulator block to Figure 7
- Revised footnotes in Table 9
- Removed plan #203 from Table 9
- Removed Figure 17. Crystal Oscillator with Feedback Resistor diagram from Section 7. "Crystal/Reference Clock Input"
- Added XA/XB jitter transfer plot to Section 7. "Crystal/Reference Clock Input"
- Added PSRR transfer function plot to Section 8. "Power Supply Filtering"
- Updated Typical phase noise plot and RMS jitter table in Section 9. "Typical Phase Noise Plots"

Revision 0.25 to Revision 0.26

 Corrected Section 11. "Ordering Guide" Output Clock Frequency Range for Si5315B-C-GM to 8 kHz–125 MHz.

Revision 0.26 to Revision 1.0

- Updated Table 2 on page 4.
- Updated Table 3 on page 8.
- Updated Table 7 on page 13.
- Moved "Typical Application Circuit" to page 14.
- Added reference to AN591.
- Bypass mode not supported with CMOS outputs.
- Changed G.8262 compliance language.
- Added frequency plans 103, 129, and 130.

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